

# LDC1312, LDC1314 Multi-Channel 12-Bit Inductance to Digital Converter (LDC) for Inductive Sensing

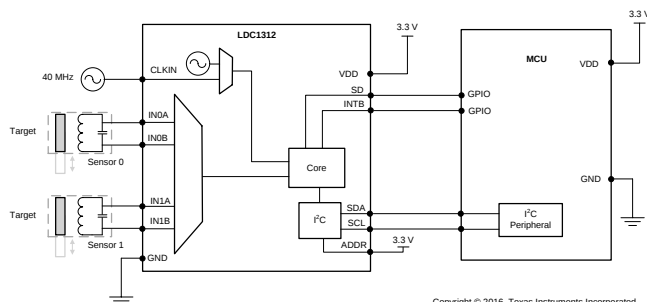
## 1 Features

- Easy-to-Use – Minimal Configuration Required
- Up to 4 Channels With Matched Sensor Drive
- Multiple Channels Support Environmental and Aging Compensation
- Remote Sensor Position of >20 cm Supports Operation In Harsh Environments
- Pin-Compatible Medium and High-Resolution Options:
  - LDC1312/4: 2/4-ch 12-Bit LDC
  - LDC1612/4: 2/4-ch 28-Bit LDC
- Supports Wide Sensor Frequency Range of 1 kHz to 10 MHz
- Power Consumption:
  - 35  $\mu$ A Low Power Sleep Mode
  - 200 nA Shutdown Mode
- 2.7 V to 3.6 V Operation
- Multiple Reference Clocking Options:
  - Included Internal Clock For Lower System Cost
  - Support for 40 MHz External Clock For Higher System performance
- Immunity to DC Magnetic Fields and Magnets

## 2 Applications

- Knobs in Consumer, Appliances, and Automotive
- Linear and Rotational Encoders
- Buttons in Home Electronics, Wearables, Manufacturing, and Automotive
- Keypads in Manufacturing and Appliances
- Slider Buttons in Consumer Products
- Metal Detection in Industrial and Automotive
- POS and EPOS
- Flow Meters in Consumer and Appliances

### Simplified Schematic



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## 3 Description

The LDC1312 and LDC1314 are 2- and 4-channel, 12-bit inductance to digital converters (LDCs) for inductive sensing solutions. With multiple channels and support for remote sensing, the LDC1312 and LDC1314 enable the performance and reliability benefits of inductive sensing to be realized at minimal cost and power. The products are easy to use, only requiring that the sensor frequency be within 1 kHz and 10 MHz to begin sensing. The wide 1 kHz to 10 MHz sensor frequency range also enables use of very small PCB coils, further reducing sensing solution cost and size.

The LDC1312 and LDC1314 offer well-matched channels, which allow for differential and ratiometric measurements. This enables designers to use one channel to compensate their sensing for environmental and aging conditions such as temperature, humidity, and mechanical drift. Given their ease of use, low power, and low system cost these products enable designers to greatly improve on existing sensing solutions and to introduce brand new sensing capabilities to products in all markets, especially consumer and industrial applications. Inductive sensing offers better performance, reliability, and flexibility than competitive sensing technologies at lower system cost and power.

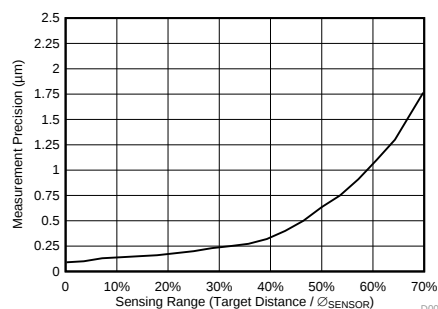
The LDC1312 and LDC1314 are easily configured via an I2C interface. The two-channel LDC1312 is available in a WSON-12 package and the four-channel LDC1314 is available in a WQFN-16 package.

### Device Information<sup>(1)</sup>

| PART NUMBER | PACKAGE | BODY SIZE (NOM) |
|-------------|---------|-----------------|
| LDC1312     | WSON-12 | 4 mm × 4 mm     |
| LDC1314     | WQFN-16 | 4 mm × 4 mm     |

(1) For all available packages, see the orderable addendum at the end of the datasheet.

### Measurement Precision vs. Target Distance



D001



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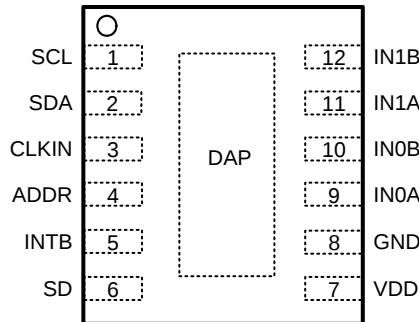
## 4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

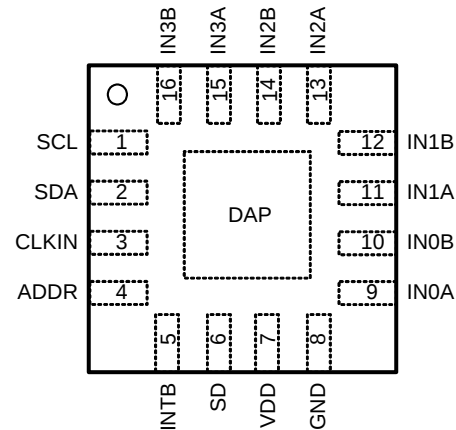
| Changes from Original (December 2014) to Revision A                                                                                                                       | Page |
|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------|
| • Changed ESD values from 1000 to 2000 and from 250 to 750 on both packages .....                                                                                         | 4    |
| • Added logic levels for ADDR, INTB, and SD pins .....                                                                                                                    | 5    |
| • Changed description of clocking architecture for improved clarity. ....                                                                                                 | 10   |
| • Changed register names and field names from CHx_NAME and NAME_CHx to NAMEx. ....                                                                                        | 14   |
| • Added instructions on setting registers with both R and R/W fields .....                                                                                                | 14   |
| • Changed register names from DATA_CHx to DATAx; and CHx_ERR_YY field names to ERR_YYx. ....                                                                              | 15   |
| • Changed ERR_AE field description on DATA0, DATA1, DATA2 and DATA3 tables. ....                                                                                          | 15   |
| • Changed register names from RCOUNT_CHx to RCOUNTx; and CHx_RCOUNT field names to RCOUNTx .....                                                                          | 17   |
| • Changed register names from OFFSET_CHx to OFFSETx; and CHx_OFFSET field names to OFFSETx .....                                                                          | 18   |
| • Changed register names from SETTLECOUNT_CHx to SETTLECOUNTx; and CHx_SETTLECOUNT field names to SETTLECOUNTx .....                                                      | 19   |
| • Changed Address of SETTLECOUNT0 and SETTLECOUNT1 were not correct on table. ....                                                                                        | 20   |
| • Changed register names from CLOCK_DIVIDERS_CHx to CLOCK_DIVIDERSx; CHx_FIN_DIVIDER field names to FIN_DIVIDERx, and CHx_FREF_DIVIDER field names to FREF_DIVIDERx. .... | 21   |
| • Changed CHx_UNREADCONV field names to UNREADCONVx .....                                                                                                                 | 23   |
| • Changed register names from DRIVE_CURRENT_CHx to DRIVE_CURRENTx; CHx_IDRIVE field names to IDRIVEx, and CHx_INIT_IDRIVE to INIT_IDRIVEx .....                           | 28   |
| • Changed Application Information section for clarity, and provided additional information on device configuration and operation. ....                                    | 31   |
| • Added instructions for using an oscilloscope to configure sensor drive current .....                                                                                    | 42   |
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| • Changed reference frequency limits from < to ≤ .....                                                                                                                    | 44   |
| • Changed to a ≥ symbol in the <i>Clock Configuration Requirements</i> table. ....                                                                                        | 44   |

## 5 Pin Configuration and Functions

**DNT and RGH Packages  
Top View**



**LDC1312 WSON-12**



**LDC1314 WQFN-16**

### Pin Functions

| PIN                |     | TYPE <sup>(1)</sup> | DESCRIPTION                                                                                                                           |
|--------------------|-----|---------------------|---------------------------------------------------------------------------------------------------------------------------------------|
| NAME               | NO. |                     |                                                                                                                                       |
| SCL                | 1   | I                   | I2C Clock input. Open drain output; requires resistive pullup to logic high level.                                                    |
| SDA                | 2   | I/O                 | I2C Data input/output. Open drain output; requires resistive pullup to logic high level.                                              |
| CLKIN              | 3   | I                   | External Reference Clock input. Tie this pin to GND if internal oscillator is used.                                                   |
| ADDR               | 4   | I                   | I2C Address selection pin: when ADDR=L, I2C address = 0x2A, when ADDR=H, I2C address = 0x2B. This input must not be allowed to float. |
| INTB               | 5   | O                   | Configurable Interrupt output pin. Push-pull output; does not require pullup.                                                         |
| SD                 | 6   | I                   | Shutdown input: set SD = L for normal operation, set SD=H for inactive mode. This input must not be allowed to float.                 |
| VDD                | 7   | P                   | Power Supply                                                                                                                          |
| GND                | 8   | G                   | Ground                                                                                                                                |
| IN0A               | 9   | A                   | External LC sensor 0 connection                                                                                                       |
| IN0B               | 10  | A                   | External LC sensor 0 connection                                                                                                       |
| IN1A               | 11  | A                   | External LC sensor 1 connection                                                                                                       |
| IN1B               | 12  | A                   | External LC sensor 1 connection                                                                                                       |
| IN2A               | 13  | A                   | External LC sensor 2 connection (LDC1314 only)                                                                                        |
| IN2B               | 14  | A                   | External LC sensor 2 connection (LDC1314 only)                                                                                        |
| IN3A               | 15  | A                   | External LC sensor 3 connection (LDC1314 only)                                                                                        |
| IN3B               | 16  | A                   | External LC sensor 3 connection (LDC1314 only)                                                                                        |
| DAP <sup>(2)</sup> | DAP | N/A                 | Connect to Ground                                                                                                                     |

(1) I = Input, O = Output, P=Power, G=Ground, A=Analog

(2) There is an internal electrical connection between the exposed Die Attach Pad (DAP) and the GND pin of the device. Although the DAP can be left floating, for best performance the DAP should be connected to the same potential as the device's GND pin. Do not use the DAP as the primary ground for the device. The device GND pin must always be connected to ground.

## 6 Specifications

### 6.1 Absolute Maximum Ratings

|           |                                  | MIN  | MAX          | UNIT |
|-----------|----------------------------------|------|--------------|------|
| $V_{DD}$  | Supply Voltage Range             |      | 5            | V    |
| $V_i$     | Voltage on any pin               | -0.3 | $V_{DD}+0.3$ | V    |
| $I_A$     | Input current on any INx pin     | -8   | 8            | mA   |
| $I_D$     | Input current on any Digital pin | -5   | 5            | mA   |
| $T_j$     | Junction Temperature             | -55  | 150          | °C   |
| $T_{stg}$ | Storage temperature range        | -65  | 150          | °C   |

- (1) Stresses beyond those listed under *Absolute Maximum Ratings* may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under *Recommended Operating Conditions*. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

### 6.2 ESD Ratings

|                                            |                                                                                | VALUE | UNIT |
|--------------------------------------------|--------------------------------------------------------------------------------|-------|------|
| LDC1312 in WSON-12 package                 |                                                                                |       |      |
| V <sub>(ESD)</sub> Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
|                                            | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±750  |      |
| LDC1314 in WQFN-16 package                 |                                                                                |       |      |
| V <sub>(ESD)</sub> Electrostatic discharge | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 <sup>(1)</sup>              | ±2000 | V    |
|                                            | Charged-device model (CDM), per JEDEC specification JESD22-C101 <sup>(2)</sup> | ±750  |      |

- (1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.  
 (2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

### 6.3 Recommended Operating Conditions

Unless otherwise specified, all limits ensured for  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{ V}$

|          |                       | MIN | NOM | MAX | UNIT |
|----------|-----------------------|-----|-----|-----|------|
| $V_{DD}$ | Supply Voltage        | 2.7 |     | 3.6 | V    |
| $T_A$    | Operating Temperature | -40 |     | 125 | °C   |

### 6.4 Thermal Information

| THERMAL METRIC <sup>(1)</sup>                          | LDC1312    | LDC1314    | UNIT |
|--------------------------------------------------------|------------|------------|------|
|                                                        | WSON (DNT) | WQFN (RGH) |      |
|                                                        | 12 PINS    | 16 PINS    |      |
| $R_{\theta JA}$ Junction-to-ambient thermal resistance | 50         | 38         | °C/W |

- (1) For more information about traditional and new thermal metrics, see the [Semiconductor and IC Package Thermal Metrics](#) application report.

## 6.5 Electrical Characteristics

Unless otherwise specified, all limits ensured for  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{ V}$ . See <sup>(1)</sup>

| PARAMETER                 |                                                                | TEST CONDITIONS <sup>(2)</sup>                                     | MIN <sup>(3)</sup> | TYP <sup>(4)</sup> | MAX <sup>(3)</sup> | UNIT          |
|---------------------------|----------------------------------------------------------------|--------------------------------------------------------------------|--------------------|--------------------|--------------------|---------------|
| <b>POWER</b>              |                                                                |                                                                    |                    |                    |                    |               |
| $V_{DD}$                  | Supply Voltage                                                 | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$                  | 2.7                |                    | 3.6                | V             |
| $I_{DD}$                  | Supply Current (not including sensor current) <sup>(5)</sup>   | $f_{CLKIN} = 10\text{ MHz}$ <sup>(6)</sup>                         |                    | 2.1                |                    | mA            |
| $I_{DDSL}$                | Sleep Mode Supply Current <sup>(5)</sup>                       | SLEEP_MODE_EN = b1                                                 |                    | 35                 | 60                 | $\mu\text{A}$ |
| $I_{SD}$                  | Shutdown Mode Supply Current <sup>(5)</sup>                    | SD = $V_{DD}$                                                      |                    | 0.2                | 1                  | $\mu\text{A}$ |
| <b>SENSOR</b>             |                                                                |                                                                    |                    |                    |                    |               |
| $I_{SENSORMAX}$           | Sensor Maximum Current drive                                   | HIGH_CURRENT_DRV = b0<br>DRIVE_CURRENTx = 0xF800                   |                    | 1.5                |                    | mA            |
| $R_P$                     | Sensor $R_P$                                                   |                                                                    | 1                  |                    | 100                | k $\Omega$    |
| $I_{HDSENSORMAX}$         | High current sensor drive mode: Sensor Maximum Current         | HIGH_CURRENT_DRV = b1<br>DRIVE_CURRENT0 = 0xF800<br>Channel 0 only |                    | 6                  |                    | mA            |
| $R_{P\_HD\_MIN}$          | Minimum sensor $R_P$                                           |                                                                    |                    | 250                |                    | $\Omega$      |
| $f_{SENSOR}$              | Sensor Resonance Frequency                                     | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$                  | 0.001              |                    | 10                 | MHz           |
| $V_{SENSORMAX}$           | Maximum oscillation amplitude (peak)                           |                                                                    |                    | 1.8                |                    | V             |
| $N_{BITS}$                | Number of bits                                                 | RESET_DEV.OUTPUT_GAIN=b00<br>RCOUNTx $\geq$ 0x0400                 |                    |                    | 12                 | bits          |
| $f_{CS}$                  | Maximum Channel Sample Rate                                    | single active channel continuous conversion, SCL=400 kHz           |                    |                    | 13.3               | kSPS          |
| $C_{IN}$                  | Sensor Pin input capacitance                                   |                                                                    |                    | 4                  |                    | pF            |
| <b>DIGITAL PIN LEVELS</b> |                                                                |                                                                    |                    |                    |                    |               |
| $V_{IL}$                  | Low voltage threshold (ADDR and SD)                            |                                                                    |                    |                    | $0.3 \cdot V_{DD}$ | V             |
| $V_{IH}$                  | High voltage threshold (ADDR and SD)                           |                                                                    | $0.7 \cdot V_{DD}$ |                    |                    | V             |
| $V_{OL}$                  | INTB low voltage output level                                  | 3mA sink current                                                   |                    |                    | 0.4                | V             |
| $V_{OH}$                  | INTB high voltage output level                                 |                                                                    | 2.4                |                    |                    | V             |
| <b>REFERENCE CLOCK</b>    |                                                                |                                                                    |                    |                    |                    |               |
| $f_{CLKIN}$               | External Reference Clock Input Frequency (CLKIN)               | $T_A = -40^\circ\text{C}$ to $+125^\circ\text{C}$                  | 2                  |                    | 40                 | MHz           |
| $CLKIN_{DUTY\_MIN}$       | External Reference Clock minimum acceptable duty cycle (CLKIN) |                                                                    |                    | 40%                |                    |               |
| $CLKIN_{DUTY\_MAX}$       | External Reference Clock maximum acceptable duty cycle (CLKIN) |                                                                    |                    | 60%                |                    |               |
| $V_{CLKIN\_LO}$           | CLKIN low voltage threshold                                    |                                                                    |                    |                    | $0.3 \cdot V_{DD}$ | V             |
| $V_{CLKIN\_HI}$           | CLKIN high voltage threshold                                   |                                                                    | $0.7 \cdot V_{DD}$ |                    |                    | V             |

- Electrical Characteristics Table values apply only for factory testing conditions at the temperature indicated. Factory testing conditions result in very limited self-heating of the device such that  $T_J = T_A$ . No guarantee of parametric performance is indicated in the electrical tables under conditions of internal self-heating where  $T_J > T_A$ . Absolute Maximum Ratings indicate junction temperature limits beyond which the device may be permanently degraded, either mechanically or electrically.
- Register values are represented as either binary (b is the prefix to the digits), or hexadecimal (0x is the prefix to the digits). Decimal values have no prefix.
- Limits are ensured by testing, design, or statistical analysis at  $25^\circ\text{C}$ . Limits over the operating temperature range are ensured through correlations using statistical quality control (SQC) method.
- Typical values represent the most likely parametric norm as determined at the time of characterization. Actual typical values may vary over time and will also depend on the application and configuration. The typical values are not tested and are not guaranteed on shipped production material.
- I<sup>2</sup>C read/write communication and pull-up resistors current through SCL, SDA not included.
- Sensor inductor: 2 layer, 32 turns/layer, 14 mm diameter, PCB inductor with  $L=19.4\text{ }\mu\text{H}$ ,  $R_P=5.7\text{ k}\Omega$  at 2 MHz Sensor capacitor: 330 pF 1% COG/NPO Target: Aluminum, 1.5 mm thickness Channel = Channel 0 (continuous mode)  $f_{CLKIN} = 40\text{ MHz}$ , FIN\_DIVIDER0 = b0000, FREF\_DIVIDER0 = 0x0001, RCOUNT0 = 0xFFFF, SETTLECOUNT0 = 0x0100, RP\_OVERRIDE = b1, AUTO\_AMP\_DIS = b1, DRIVE\_CURRENT0 = 0x9800

## Electrical Characteristics (continued)

Unless otherwise specified, all limits ensured for  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{ V}$ . See <sup>(1)</sup>

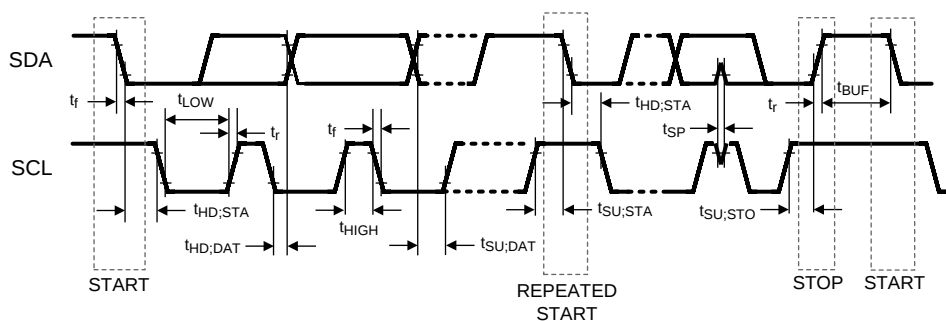
| PARAMETER                     | TEST CONDITIONS <sup>(2)</sup>                           | MIN <sup>(3)</sup> | TYP <sup>(4)</sup> | MAX <sup>(3)</sup> | UNIT                  |
|-------------------------------|----------------------------------------------------------|--------------------|--------------------|--------------------|-----------------------|
| $f_{\text{INTCLK}}$           | Internal Reference Clock Frequency range                 | 35                 | 43.4               | 55                 | MHz                   |
| $T_{\text{Cf\_int\_}\mu}$     | Internal Reference Clock Temperature Coefficient mean    |                    | -13                |                    | ppm/ $^\circ\text{C}$ |
| <b>TIMING CHARACTERISTICS</b> |                                                          |                    |                    |                    |                       |
| $t_{\text{WAKEUP}}$           | Wake-up Time from SD high-low transition to I2C readback |                    |                    | 2                  | ms                    |
| $t_{\text{WD-TIMEOUT}}$       | Sensor recovery time (after watchdog timeout)            |                    | 5.2                |                    | ms                    |

## 6.6 Switching Characteristics - I2C

Unless otherwise specified, all limits ensured for  $T_A = 25^\circ\text{C}$ ,  $V_{DD} = 3.3\text{ V}$

| PARAMETER                         | TEST CONDITIONS                                                                  | MIN                        | TYP                        | MAX                        | UNIT          |
|-----------------------------------|----------------------------------------------------------------------------------|----------------------------|----------------------------|----------------------------|---------------|
| <b>VOLTAGE LEVELS</b>             |                                                                                  |                            |                            |                            |               |
| $V_{\text{IH}}$                   | Input High Voltage                                                               | $0.7 \times V_{\text{DD}}$ |                            |                            | V             |
| $V_{\text{IL}}$                   | Input Low Voltage                                                                |                            |                            | $0.3 \times V_{\text{DD}}$ | V             |
| $V_{\text{OL}}$                   | Output Low Voltage (3mA sink current)                                            |                            |                            | 0.4                        | V             |
| HYS                               | Hysteresis                                                                       |                            | $0.1 \times V_{\text{DD}}$ |                            | V             |
| <b>I2C TIMING CHARACTERISTICS</b> |                                                                                  |                            |                            |                            |               |
| $f_{\text{SCL}}$                  | Clock Frequency                                                                  | 10                         |                            | 400                        | kHz           |
| $t_{\text{LOW}}$                  | Clock Low Time                                                                   | 1.3                        |                            |                            | $\mu\text{s}$ |
| $t_{\text{HIGH}}$                 | Clock High Time                                                                  | 0.6                        |                            |                            | $\mu\text{s}$ |
| $t_{\text{HD;STA}}$               | Hold Time (repeated) START condition                                             | 0.6                        |                            |                            | $\mu\text{s}$ |
| $t_{\text{SU;STA}}$               | Set-up time for a repeated START condition                                       | 0.6                        |                            |                            | $\mu\text{s}$ |
| $t_{\text{HD;DAT}}$               | Data hold time                                                                   | 0                          |                            |                            | $\mu\text{s}$ |
| $t_{\text{SU;DAT}}$               | Data setup time                                                                  | 100                        |                            |                            | ns            |
| $t_{\text{SU;STO}}$               | Set-up time for STOP condition                                                   | 0.6                        |                            |                            | $\mu\text{s}$ |
| $t_{\text{BUF}}$                  | Bus free time between a STOP and START condition                                 | 1.3                        |                            |                            | $\mu\text{s}$ |
| $t_{\text{VD;DAT}}$               | Data valid time                                                                  |                            |                            | 0.9                        | $\mu\text{s}$ |
| $t_{\text{VD;ACK}}$               | Data valid acknowledge time                                                      |                            |                            | 0.9                        | $\mu\text{s}$ |
| $t_{\text{SP}}$                   | Pulse width of spikes that must be suppressed by the input filter <sup>(1)</sup> |                            |                            | 50                         | ns            |

(1) This parameter is specified by design and/or characterization and is not tested in production.



**Figure 1. I2C Timing**

## 6.7 Typical Characteristics

Common test conditions (unless specified otherwise): Sensor inductor: 2 layer, 32 turns/layer, 14 mm diameter, PCB inductor with  $L=19.4\ \mu\text{H}$ ,  $R_p=5.7\ \text{k}\Omega$  at 2 MHz; Sensor capacitor: 330 pF 1% COG/NP0; Target: Aluminum, 1.5 mm thickness; Channel = Channel 0 (continuous mode);  $f_{\text{CLKIN}} = 40\ \text{MHz}$ ,  $\text{FIN\_DIVIDER0} = 0x1$ ,  $\text{FREF\_DIVIDER0} = 0x001$ ,  $\text{RCOUNT0} = 0xFFFF$ ,  $\text{SETTLECOUNT0} = 0x0100$ ,  $\text{RP\_OVERRIDE} = 1$ ,  $\text{AUTO\_AMP\_DIS} = 1$ ,  $\text{DRIVE\_CURRENT0} = 0x9800$

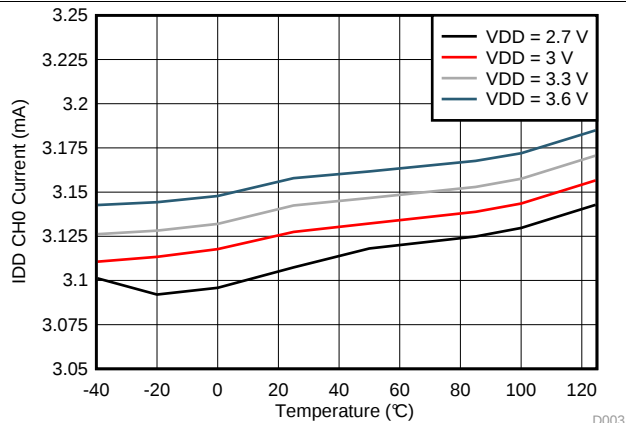
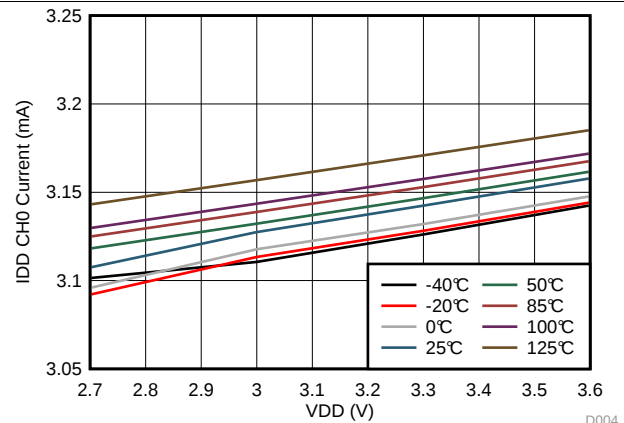


Figure 2. Active Mode  $I_{\text{DD}}$  vs. Temperature



Includes 1.57 mA sensor coil current

Figure 3. Active Mode  $I_{\text{DD}}$  vs.  $V_{\text{DD}}$

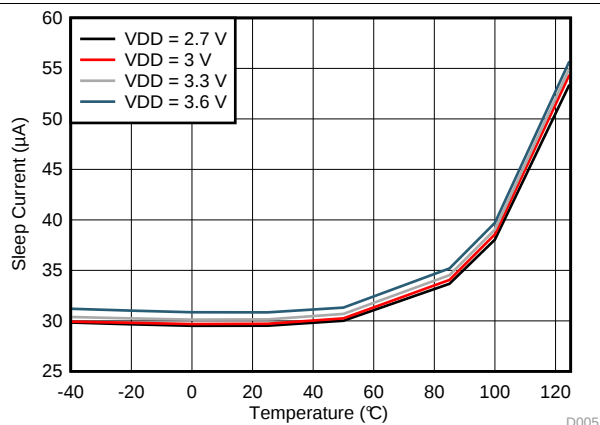


Figure 4. Sleep Mode  $I_{\text{DD}}$  vs. Temperature

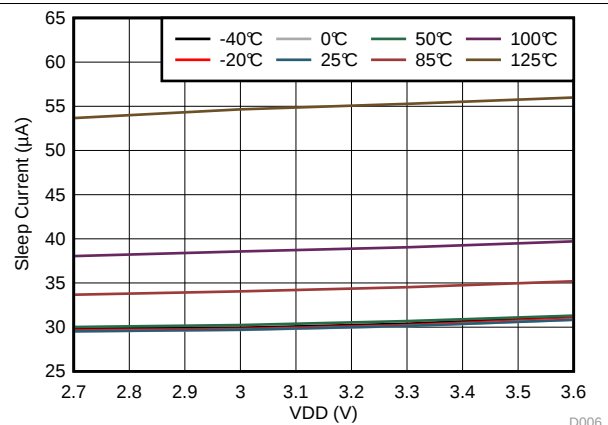


Figure 5. Sleep Mode  $I_{\text{DD}}$  vs.  $V_{\text{DD}}$

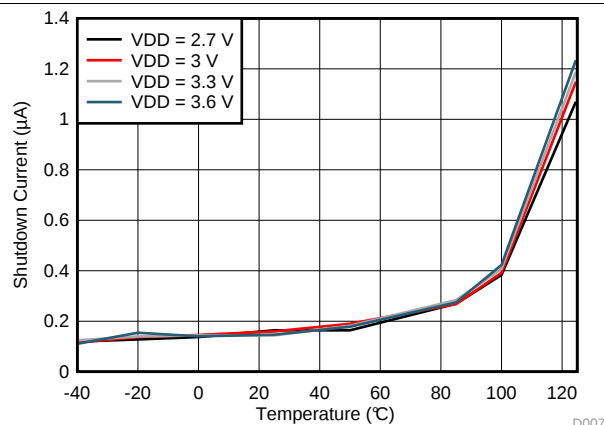


Figure 6. Shutdown Mode  $I_{\text{DD}}$  vs. Temperature

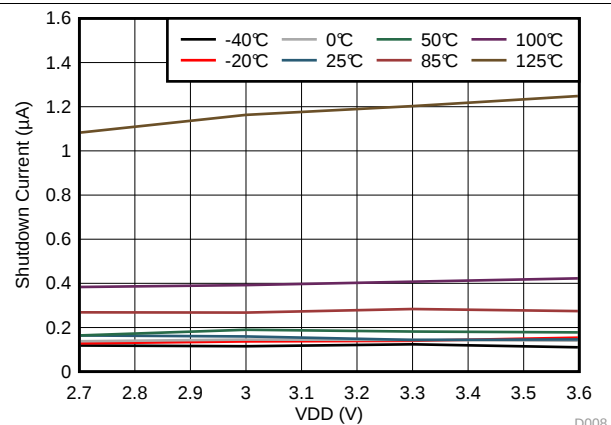
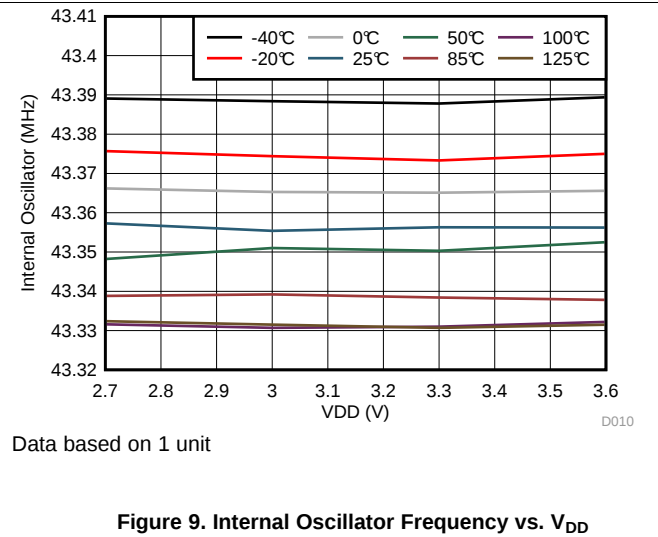
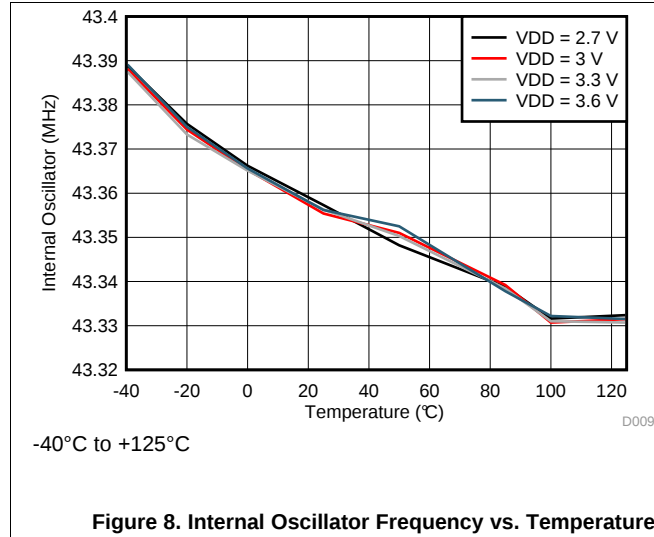


Figure 7. Shutdown Mode  $I_{\text{DD}}$  vs.  $V_{\text{DD}}$

## Typical Characteristics (continued)

Common test conditions (unless specified otherwise): Sensor inductor: 2 layer, 32 turns/layer, 14 mm diameter, PCB inductor with  $L=19.4\ \mu\text{H}$ ,  $R_p=5.7\ \text{k}\Omega$  at 2 MHz; Sensor capacitor: 330 pF 1% COG/NP0; Target: Aluminum, 1.5 mm thickness; Channel = Channel 0 (continuous mode);  $f_{\text{CLKIN}} = 40\ \text{MHz}$ ,  $\text{FIN\_DIVIDER0} = 0x1$ ,  $\text{FREF\_DIVIDER0} = 0x001$ ,  $\text{RCOUNT0} = 0xFFFF$ ,  $\text{SETTLECOUNT0} = 0x0100$ ,  $\text{RP\_OVERRIDE} = 1$ ,  $\text{AUTO\_AMP\_DIS} = 1$ ,  $\text{DRIVE\_CURRENT0} = 0x9800$



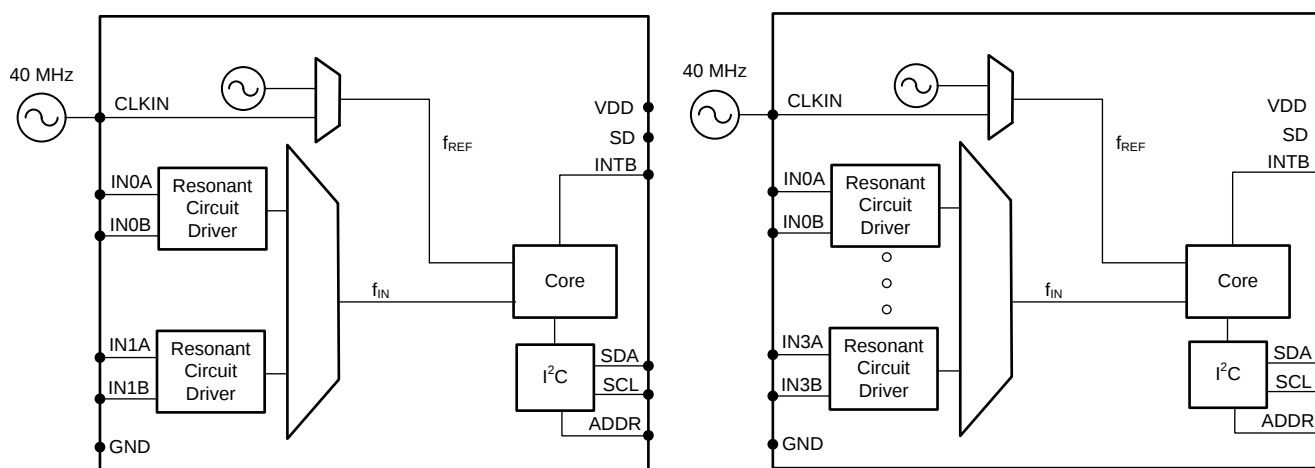
## 7 Detailed Description

### 7.1 Overview

The LDC1312/LDC1314 is an inductance-to-digital converter (LDC) that measures the oscillation frequency of multiple LC resonators. The device outputs a digital value that is proportional to frequency, with 12 bits of measurement resolution. This frequency measurement can be converted to an equivalent inductance, or mapped to the movement of a conductive object. The LDC1312/LDC1314 supports a wide range of inductance and capacitor combinations with oscillation frequencies varying from 1 kHz to 10 MHz with equivalent parallel resistances as low as 1.0 k $\Omega$ . The device includes a stable internal reference to reduce overall system cost, while also providing the option to drive a clean external oscillator for improved measurement noise. The conversion time of the LDC1312/LDC1314 is configurable per channel, where longer conversion times provide higher effective resolution.

The LDC1312/LDC1314 is configured through a 400-kbit/s I2C bus and includes the ADDR input pin to select an address. The power supply of the device ranges from 2.7 V to 3.6 V. The only external components necessary for operation are the supply bypassing capacitors and I2C pull-ups.

### 7.2 Functional Block Diagram



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**Figure 10. Block Diagrams for the LDC1312 (Left) and LDC1314 (Right)**

The LDC1312/LDC1314 is composed of front-end resonant circuit drivers, followed by a multiplexer that sequences through the active channels, connecting them to the core that measures and digitizes the sensor frequency ( $f_{\text{SENSOR}}$ ). The core uses a reference frequency ( $f_{\text{REF}}$ ) to measure the sensor frequency.  $f_{\text{REF}}$  is derived from either the internal reference clock (oscillator), or an externally supplied clock. The digitized output for each channel is proportional to the ratio of  $f_{\text{SENSOR}}/f_{\text{REF}}$ . The I2C interface is used to support device configuration and to transmit the digitized frequency values to a host processor. The LDC can be placed in an inactive shutdown mode to reduce current consumption by setting the SD pin to  $V_{\text{DD}}$ . The INTB pin may be configured to notify the host of changes in system status.

### 7.3 Feature Description

#### 7.3.1 Multi-Channel and Single Channel Operation

The LDC1312/LDC1314 provides flexibility in channel sampling. It can continuously convert on any available single channel or automatically sequence conversions across multiple channels. When operated in multi-channel mode, the LDC sequentially samples the selected channels. In single channel mode, the LDC continuously samples only the selected channel.

## Feature Description (continued)

At the end of each conversion in single channel mode, or after converting all selected channels when in multi-channel mode, the LDC1312/LDC1314 can be configured to assert the INTB pin to indicate completion of the conversion.

Refer to [Multi-Channel and Single Channel Operation](#) for details on the LDC1312/LDC1314 channel functionality and configuration.

### 7.3.2 Adjustable Conversion Time

The LDC1312/LDC1314 conversion provides a tradeoff between measurement resolution and conversion interval. Longer conversion intervals have higher measurement resolution. The conversion interval can be configured from 3.2  $\mu$ s to >26.2 ms with 16 bits of resolution. Note that it is possible to configure the conversion interval to be shorter than the time required to read back the DATAx registers. The LDC1312/LDC1314 supports per-channel adjustment of the conversion interval by setting the RCOUNTx register.

Refer to [Sensor Conversion Time](#) for details on the LDC1312/LDC1314 configuration and details on the setting conversion interval.

### 7.3.3 Digital Signal Gain

The LDC1312/LDC1314 output resolution is 12 bits, but the internal signal path supports 16 bits of output resolution by use of the GAIN setting.

Refer to [Digital Signal Gain](#) for details on the configuration and details on the setting conversion interval.

### 7.3.4 Sensor Startup and Glitch Configuration

For minimum noise, the sensor measurement should be performed after the sensor amplitude has stabilized. The LDC1312/LDC1314 provides an adjustable sensor startup timing per channel. The timing can be varied from 1.2  $\mu$ s to >26.2 ms by setting the SETTLECOUNTx register. Sensors with lower resonant frequencies or higher Qs may require additional time to stabilize.

Refer to [Settling Time](#) for details on the LDC1312/LDC1314 configuration and details on the setting conversion interval.

The LDC1312/LDC1314 can be configured with a faster sensor activation, or to use a lower current sensor activation. Refer to [Sensor Activation](#) for details on this capability.

The LDC1312/LDC1314 provides an internal filter to attenuate interference from external noise sources. Refer to [Input Deglitch Filter](#) for information on configuration on the deglitch filter.

### 7.3.5 Reference Clock

Optimum LDC1312/LDC1314 performance requires a clean reference clock. This reference frequency is equivalent to the reference voltage of an Analog-to-Digital converter. The LDC1312/LDC1314 provide an internal reference oscillator with a typical frequency of 43 MHz. This internal oscillator has good stability, with a typical temperature coefficient of -13 ppm/°C. For applications requiring higher resolution or improved performance across temperature, an external reference frequency can be applied to the CLKIN input.

The LDC1312/LDC1314 provides digital dividers for the  $f_{CLK}$  and the sensor inputs to adjust the effective frequency measured by the LDC core. The dividers provide flexibility in system design, so that the full range of sensor frequencies can be supported with a wide range of  $f_{CLK}$ . Each channel has a dedicated divider configuration. Higher reference frequencies provide a higher sample rate for a given resolution.

Refer to [Reference Clock](#) for details on clocking requirements, configuration, and divider setup.

## Feature Description (continued)

### 7.3.6 Sensor Current Drive Control

The lossy characteristic of the sensors used for inductive sensing require injection of energy to maintain a constant sensor amplitude. The LDC1312/LDC1314 provides this energy by driving an AC current matching the sensor resonant frequency across the LC sensor. To achieve optimum performance, it is necessary to set the current drive so that the sensor amplitude is within the range of  $1.2 V_p$  to  $1.8 V_p$ . Each channel current drive is set independently between  $16 \mu A$  and  $1.6 mA$  by setting the corresponding IDRIVEx register field. The LDC1312/LDC1314 can also automatically determine the appropriate sensor current drive, and even dynamically adjust the sensor current by use of the RP\_OVERRIDE\_EN function.

Refer to [Sensor Current Drive Configuration](#) for detailed information on configuration of the sensor drive.

### 7.3.7 Device Status Monitoring

The LDC1312/LDC1314 can monitor attached sensors and can report on device status and sensor status via the I2C interface. Reported conditions include:

- Sensor Amplitude outside of optimum range
- Sensor unable to oscillate
- New conversion data available
- Conversion errors

Use of this monitoring functionality can alert the system MCU of unexpected conditions such as sensor damage. Refer to [Device Status Registers](#) for more information.

## 7.4 Device Functional Modes

### 7.4.1 Startup Mode

When the LDC powers up, it enters into Sleep Mode and will wait for configuration. Once the device is configured, exit Sleep Mode and begin conversions by setting CONFIG.SLEEP\_MODE\_EN to b0.

It is recommended to configure the LDC while in Sleep Mode. If a setting on the LDC needs to be changed, return the device to Sleep Mode, change the appropriate register, and then exit Sleep Mode.

### 7.4.2 Sleep Mode (Configuration Mode)

Sleep Mode is entered by setting the CONFIG.SLEEP\_MODE\_EN register field to 1. While in this mode, the device configuration is retained, but the device does not perform conversions. To enter Normal mode to perform conversions, set the CONFIG.SLEEP\_MODE\_EN register field to 0. After setting CONFIG.SLEEP\_MODE\_EN to b0, sensor activation for the first conversion will begin after  $16,384 \div f_{INT}$  elapses. Refer to [Clocking Architecture](#) for more information on the device timing.

While in Sleep Mode the I2C interface is functional so that register reads and writes can be performed. Entering Sleep Mode will clear all conversion results, any error conditions, and de-assert the INTB pin.

For applications which do not require continuous conversions, returning the device to Sleep mode after completion and readback of the desired number of conversions can provide power consumption savings. Refer to the TI Applications Note [Power Reduction Techniques for the LDC131x/161x for Inductive Sensing](#) for more information.

### 7.4.3 Normal (Conversion) Mode

When operating in the normal (conversion) mode, the LDC is repeatedly sampling the frequency of the sensor(s) and generating sample outputs for the active channel(s) based on the device configuration.

### 7.4.4 Shutdown Mode

When the SD pin is set to high, the LDC will enter Shutdown Mode. Shutdown Mode is the lowest power state. To exit Shutdown Mode and enter Sleep Mode, set the SD pin to low. Entering Shutdown Mode will return all registers to their default state.

## Device Functional Modes (continued)

While in Shutdown Mode, no conversions are performed. In addition, entering Shutdown Mode will clear any error condition and de-assert the INTB pin (when de-asserted, INTB will be actively driven high). While the device is in Shutdown Mode, is not possible to read to or write from the device via the I2C interface.

It is permitted to change the ADDR pin setting while in Shutdown Mode.

### 7.4.4.1 Reset

The device can be reset by writing to RESET\_DEV.RESET\_DEV. Any active conversion will stop and all registers will return to their default values. This register bit will always return 0b when read.

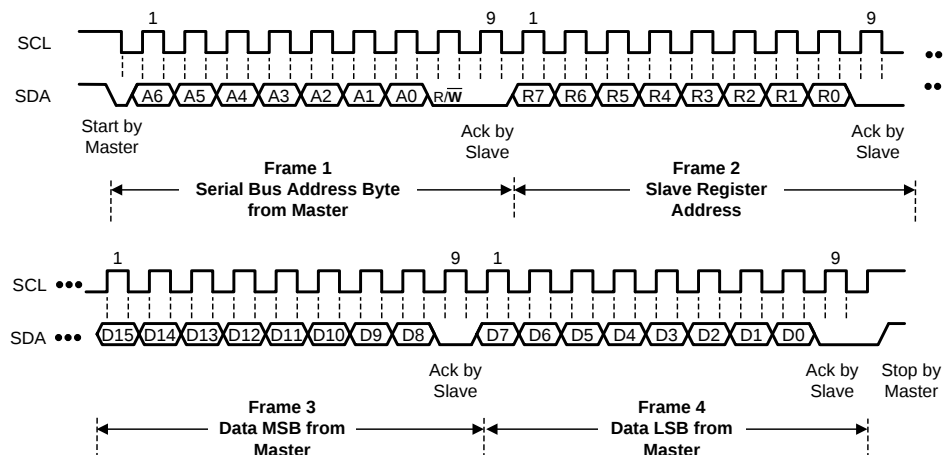
## 7.5 Programming

The LDC1312/4 device uses an I2C interface to access control and data registers. The recommended configuration procedure is to put the device into Sleep Mode, set the appropriate registers, and then enter Normal Mode. Conversion results must be read while the device is in Normal Mode. Setting the device into Shutdown mode will reset the device configuration.

### 7.5.1 I2C Interface Specifications

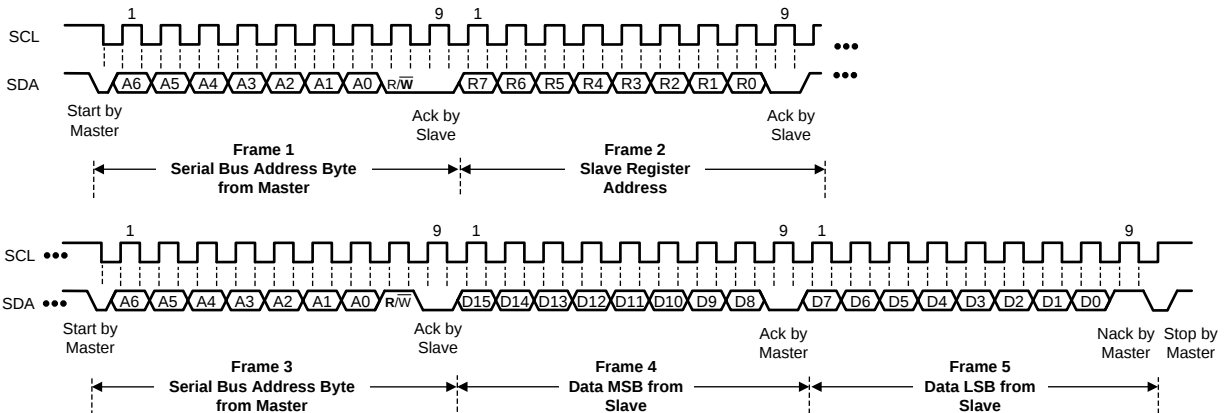
The LDC1312/4 use I2C for register access with a maximum speed of 400 kbit/s. The device registers are 16 bits wide, and so a repeated start is used to access the 2<sup>nd</sup> byte of data. This sequence follows the standard I2C 7bit slave address followed by an 8 bit pointer register byte to set the register address. Refer to [Figure 11](#) and [Figure 12](#) for proper protocol diagrams. The device does not use I2C clock stretching.

When the ADDR pin is set low, the device I2C address is 0x2A; when the ADDR pin is set high, the I2C address is 0x2B. The ADDR pin setting can be changed while the device is in Shutdown Mode to select the alternate I2C address.



**Figure 11. I2C Write Register Sequence**

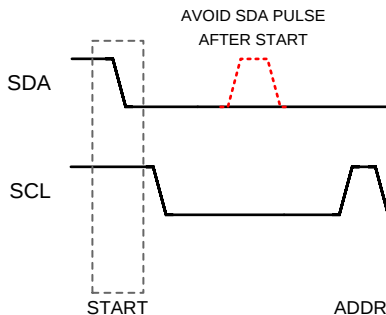
## Programming (continued)



**Figure 12. I2C Read Register Sequence**

### 7.5.2 Pulses on I2C

The I2C interface of the LDC is designed to operate with the standard I2C transactions detailed in the I2C specification; however it is not suitable for use in an I2C system which supports early termination of transactions. A STOP condition or other early termination occurring before the normal end of a transaction (ACK) is not supported and may corrupt that transaction and/or the following transaction. The device is also sensitive to any (extraneous) pulse on SDA during the SCL low period of the first bit position of the i2c\_address byte. To ensure proper LDC operation, the master device should not transmit this type of waveform. An example of an unsupported I2C waveform is shown in [Figure 13](#). Any such pulses should not have a duration which exceeds the device  $t_{SP}$  specification.



**Figure 13. Example of SDA Pulse Between I2C START and ADDR Which Must be Avoided by the I2C Master**

## 7.6 Register Maps

### 7.6.1 Register List

Fields indicated with **Reserved** must be written only with indicated value, otherwise improper device operation may occur. The R/W column indicates the Read-Write status of the corresponding field. A 'R/W' entry indicates read and write capability, a 'R' indicates read-only, and a 'W' indicates write-only.

For registers with R and R/W fields, write the reset value to the field when setting the R/W fields.

**Figure 14. Register List**

| ADDRESS | NAME            | DEFAULT VALUE | DESCRIPTION                                                               |
|---------|-----------------|---------------|---------------------------------------------------------------------------|
| 0x00    | DATA0           | 0x0000        | Channel 0 Conversion Result and Error Status                              |
| 0x02    | DATA1           | 0x0000        | Channel 1 Conversion Result and Error Status                              |
| 0x04    | DATA2           | 0x0000        | Channel 2 Conversion Result and Error Status <b>(LDC1314 only)</b>        |
| 0x06    | DATA3           | 0x0000        | Channel 3 Conversion Result and Error Status <b>(LDC1314 only)</b>        |
| 0x08    | RCOUNT0         | 0x0080        | Reference Count setting for Channel 0                                     |
| 0x09    | RCOUNT1         | 0x0080        | Reference Count setting for Channel 1                                     |
| 0x0A    | RCOUNT2         | 0x0080        | Reference Count setting for Channel 2. <b>(LDC1314 only)</b>              |
| 0x0B    | RCOUNT3         | 0x0080        | Reference Count setting for Channel 3. <b>(LDC1314 only)</b>              |
| 0x0C    | OFFSET0         | 0x0000        | Offset value for Channel 0                                                |
| 0x0D    | OFFSET1         | 0x0000        | Offset value for Channel 1                                                |
| 0x0E    | OFFSET2         | 0x0000        | Offset value for Channel 2 <b>(LDC1314 only)</b>                          |
| 0x0F    | OFFSET3         | 0x0000        | Offset value for Channel 3 <b>(LDC1314 only)</b>                          |
| 0x10    | SETTLECOUNT0    | 0x0000        | Channel 0 Settling Reference Count                                        |
| 0x11    | SETTLECOUNT1    | 0x0000r       | Channel 1 Settling Reference Count                                        |
| 0x12    | SETTLECOUNT2    | 0x0000        | Channel 2 Settling Reference Count <b>(LDC1314 only)</b>                  |
| 0x13    | SETTLECOUNT3    | 0x0000        | Channel 3 Settling Reference Count <b>(LDC1314 only)</b>                  |
| 0x14    | CLOCK_DIVIDERS0 | 0x0000        | Reference and Sensor Divider settings for Channel 0                       |
| 0x15    | CLOCK_DIVIDERS1 | 0x0000        | Reference and Sensor Divider settings for Channel 1                       |
| 0x16    | CLOCK_DIVIDERS2 | 0x0000        | Reference and Sensor Divider settings for Channel 2 <b>(LDC1314 only)</b> |
| 0x17    | CLOCK_DIVIDERS3 | 0x0000        | Reference and Sensor Divider settings for Channel 3 <b>(LDC1314 only)</b> |
| 0x18    | STATUS          | 0x0000        | Device Status Report                                                      |
| 0x19    | ERROR_CONFIG    | 0x0000        | Error Reporting Configuration                                             |
| 0x1A    | CONFIG          | 0x2801        | Conversion Configuration                                                  |
| 0x1B    | MUX_CONFIG      | 0x020F        | Channel Multiplexing Configuration                                        |
| 0x1C    | RESET_DEV       | 0x0000        | Reset Device                                                              |
| 0x1E    | DRIVE_CURRENT0  | 0x0000        | Channel 0 sensor current drive configuration                              |
| 0x1F    | DRIVE_CURRENT1  | 0x0000        | Channel 1 sensor current drive configuration                              |
| 0x20    | DRIVE_CURRENT2  | 0x0000        | Channel 2 sensor current drive configuration <b>(LDC1314 only)</b>        |
| 0x21    | DRIVE_CURRENT3  | 0x0000        | Channel 3 sensor current drive configuration <b>(LDC1314 only)</b>        |
| 0x7E    | MANUFACTURER_ID | 0x5449        | Manufacturer ID                                                           |
| 0x7F    | DEVICE_ID       | 0x3054        | Device ID                                                                 |

## 7.6.2 Address 0x00, DATA0

**Figure 15. Address 0x00, DATA0**

|             |         |         |         |             |    |   |   |
|-------------|---------|---------|---------|-------------|----|---|---|
| 15          | 14      | 13      | 12      | 11          | 10 | 9 | 8 |
| ERR_UR0     | ERR_OR0 | ERR_WD0 | ERR_AE0 | DATA0[11:0] |    |   |   |
| 7           | 6       | 5       | 4       | 3           | 2  | 1 | 0 |
| DATA0[11:0] |         |         |         |             |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 1. Address 0x00, DATA0 Field Descriptions**

| Bit  | Field       | Type | Reset | Description                                                                            |
|------|-------------|------|-------|----------------------------------------------------------------------------------------|
| 15   | ERR_UR0     | R    | 0     | <b>Channel 0 Conversion Under-range Error Flag</b><br>Cleared by reading the bit.      |
| 14   | ERR_OR0     | R    | 0     | <b>Channel 0 Conversion Over-range Error Flag</b><br>Cleared by reading the bit.       |
| 13   | ERR_WD0     | R    | 0     | <b>Channel 0 Conversion Watchdog Timeout Error Flag</b><br>Cleared by reading the bit. |
| 12   | ERR_AE0     | R    | 0     | <b>Channel 0 Conversion Amplitude Error Flag.</b><br>Cleared by reading the bit.       |
| 11:0 | DATA0[11:0] | R    | 0x000 | <b>Channel 0 Conversion Result</b>                                                     |

## 7.6.3 Address 0x02, DATA1

**Figure 16. Address 0x02, DATA1**

|             |         |         |         |             |    |   |   |
|-------------|---------|---------|---------|-------------|----|---|---|
| 15          | 14      | 13      | 12      | 11          | 10 | 9 | 8 |
| ERR_UR1     | ERR_OR1 | ERR_WD1 | ERR_AE1 | DATA1[11:0] |    |   |   |
| 7           | 6       | 5       | 4       | 3           | 2  | 1 | 0 |
| DATA1[11:0] |         |         |         |             |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 2. Address 0x02, DATA1 Field Descriptions**

| Bit  | Field       | Type | Reset | Description                                                                            |
|------|-------------|------|-------|----------------------------------------------------------------------------------------|
| 15   | ERR_UR1     | R    | 0     | <b>Channel 1 Conversion Under-range Error Flag</b><br>Cleared by reading the bit.      |
| 14   | ERR_OR1     | R    | 0     | <b>Channel 1 Conversion Over-range Error Flag</b><br>Cleared by reading the bit.       |
| 13   | ERR_WD1     | R    | 0     | <b>Channel 1 Conversion Watchdog Timeout Error Flag</b><br>Cleared by reading the bit. |
| 12   | ERR_AE1     | R    | 0     | <b>Channel 1 Conversion Amplitude Error Flag</b><br>Cleared by reading the bit.        |
| 11:0 | DATA1[11:0] | R    | 0x000 | <b>Channel 1 Conversion Result</b>                                                     |

**LDC1312, LDC1314**

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**7.6.4 Address 0x04, DATA2 (LDC1314 only)**
**Figure 17. Address 0x04, DATA2**

|             |         |         |         |             |    |   |   |
|-------------|---------|---------|---------|-------------|----|---|---|
| 15          | 14      | 13      | 12      | 11          | 10 | 9 | 8 |
| ERR_UR2     | ERR_OR2 | ERR_WD2 | ERR_AE2 | DATA2[11:0] |    |   |   |
| 7           | 6       | 5       | 4       | 3           | 2  | 1 | 0 |
| DATA2[11:0] |         |         |         |             |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 3. Address 0x04, DATA2 Field Descriptions**

| Bit  | Field       | Type | Reset | Description                                                                            |
|------|-------------|------|-------|----------------------------------------------------------------------------------------|
| 15   | ERR_UR2     | R    | 0     | <b>Channel 2 Conversion Under-range Error Flag</b><br>Cleared by reading the bit.      |
| 14   | ERR_OR2     | R    | 0     | <b>Channel 2 Conversion Over-range Error Flag</b><br>Cleared by reading the bit.       |
| 13   | ERR_WD2     | R    | 0     | <b>Channel 2 Conversion Watchdog Timeout Error Flag</b><br>Cleared by reading the bit. |
| 12   | ERR_AE2     | R    | 0     | <b>Channel 2 Conversion Amplitude Error Flag</b><br>Cleared by reading the bit.        |
| 11:0 | DATA2[11:0] | R    | 0x000 | <b>Channel 2 Conversion Result</b>                                                     |

**7.6.5 Address 0x06, DATA3 (LDC1314 only)**
**Figure 18. Address 0x06, DATA3**

|              |         |         |         |              |    |   |   |
|--------------|---------|---------|---------|--------------|----|---|---|
| 15           | 14      | 13      | 12      | 11           | 10 | 9 | 8 |
| ERR_UR3      | ERR_OR3 | ERR_WD3 | ERR_AE3 | DATA3 [11:0] |    |   |   |
| 7            | 6       | 5       | 4       | 3            | 2  | 1 | 0 |
| DATA3 [11:0] |         |         |         |              |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 4. Address 0x06, DATA3 Field Descriptions**

| Bit  | Field       | Type | Reset | Description                                                                            |
|------|-------------|------|-------|----------------------------------------------------------------------------------------|
| 15   | ERR_UR3     | R    | 0     | <b>Channel 3 Conversion Under-range Error Flag</b><br>Cleared by reading the bit.      |
| 14   | ERR_OR3     | R    | 0     | <b>Channel 3 Conversion Over-range Error Flag</b><br>Cleared by reading the bit.       |
| 13   | ERR_WD3     | R    | 0     | <b>Channel 3 Conversion Watchdog Timeout Error Flag</b><br>Cleared by reading the bit. |
| 12   | ERR_AE3     | R    | 0     | <b>Channel 3 Conversion Amplitude Error Flag</b><br>Cleared by reading the bit.        |
| 11:0 | DATA3[11:0] | R    | 0x000 | <b>Channel 3 Conversion Result</b>                                                     |

## 7.6.6 Address 0x08, RCOUNT0

**Figure 19. Address 0x08, RCOUNT0**

|         |    |    |    |    |    |   |   |
|---------|----|----|----|----|----|---|---|
| 15      | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| RCOUNT0 |    |    |    |    |    |   |   |
| 7       | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RCOUNT0 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 5. Address 0x08, RCOUNT0 Field Descriptions**

| Bit  | Field   | Type | Reset  | Description                                                                                                                                                    |
|------|---------|------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:0 | RCOUNT0 | R/W  | 0x0080 | <b>Channel 0 Reference Count Conversion Interval Time</b><br>0x0000-0x0004: Reserved<br>0x0005-0xFFFF: Conversion Time ( $t_{C0}$ ) = (RCOUNT0×16)/ $f_{REF0}$ |

## 7.6.7 Address 0x09, RCOUNT1

**Figure 20. Address 0x09, RCOUNT1**

|         |    |    |    |    |    |   |   |
|---------|----|----|----|----|----|---|---|
| 15      | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| RCOUNT1 |    |    |    |    |    |   |   |
| 7       | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RCOUNT1 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 6. Address 0x09, RCOUNT1 Field Descriptions**

| Bit  | Field   | Type | Reset  | Description                                                                                                                                                    |
|------|---------|------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:0 | RCOUNT1 | R/W  | 0x0080 | <b>Channel 1 Reference Count Conversion Interval Time</b><br>0x0000-0x0004: Reserved<br>0x0005-0xFFFF: Conversion Time ( $t_{C1}$ ) = (RCOUNT1×16)/ $f_{REF1}$ |

## 7.6.8 Address 0x0A, RCOUNT2 (LDC1314 only)

**Figure 21. Address 0x0A, RCOUNT2**

|         |    |    |    |    |    |   |   |
|---------|----|----|----|----|----|---|---|
| 15      | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| RCOUNT2 |    |    |    |    |    |   |   |
| 7       | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RCOUNT2 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 7. Address 0x0A, RCOUNT2 Field Descriptions**

| Bit  | Field   | Type | Reset  | Description                                                                                                                                                    |
|------|---------|------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:0 | RCOUNT2 | R/W  | 0x0080 | <b>Channel 2 Reference Count Conversion Interval Time</b><br>0x0000-0x0004: Reserved<br>0x0005-0xFFFF: Conversion Time ( $t_{C2}$ ) = (RCOUNT2×16)/ $f_{REF2}$ |

## 7.6.9 Address 0x0B, RCOUNT3 (LDC1314 only)

**Figure 22. Address 0x0B, RCOUNT3**

|         |    |    |    |    |    |   |   |
|---------|----|----|----|----|----|---|---|
| 15      | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| RCOUNT3 |    |    |    |    |    |   |   |
| 7       | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| RCOUNT3 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 8. Address 0x0B, RCOUNT3 Field Descriptions**

| Bit  | Field   | Type | Reset  | Description                                                                                                                                                          |
|------|---------|------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:0 | RCOUNT3 | R/W  | 0x0080 | <b>Channel 3 Reference Count Conversion Interval Time</b><br>0x0000-0x0004: Reserved<br>0x0005-0xFFFF: Conversion Time ( $t_{C3} = (RCOUNT3 \times 16) / f_{REF3}$ ) |

## 7.6.10 Address 0x0C, OFFSET0

**Figure 23. Address 0x0C, OFFSET0**

|         |    |    |    |    |    |   |   |
|---------|----|----|----|----|----|---|---|
| 15      | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OFFSET0 |    |    |    |    |    |   |   |
| 7       | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| OFFSET0 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 9. OFFSET0 Field Descriptions**

| Bit  | Field   | Type | Reset  | Description                                                                                 |
|------|---------|------|--------|---------------------------------------------------------------------------------------------|
| 15:0 | OFFSET0 | R/W  | 0x0000 | <b>Channel 0 Conversion Offset</b><br>$f_{OFFSET0} = (OFFSET0 \div 2^{16}) \times f_{REF0}$ |

## 7.6.11 Address 0x0D, OFFSET1

**Figure 24. Address 0x0D, OFFSET1**

|         |    |    |    |    |    |   |   |
|---------|----|----|----|----|----|---|---|
| 15      | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OFFSET1 |    |    |    |    |    |   |   |
| 7       | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| OFFSET1 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 10. Address 0x0D, OFFSET1 Field Descriptions**

| Bit  | Field   | Type | Reset  | Description                                                                                 |
|------|---------|------|--------|---------------------------------------------------------------------------------------------|
| 15:0 | OFFSET1 | R/W  | 0x0000 | <b>Channel 1 Conversion Offset</b><br>$f_{OFFSET1} = (OFFSET1 \div 2^{16}) \times f_{REF1}$ |

### 7.6.12 Address 0x0E, OFFSET2 (LDC1314 only)

**Figure 25. Address 0x0E, OFFSET2**

|         |    |    |    |    |    |   |   |
|---------|----|----|----|----|----|---|---|
| 15      | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OFFSET2 |    |    |    |    |    |   |   |
| 7       | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| OFFSET2 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 11. Address 0x0E, OFFSET2 Field Descriptions**

| Bit  | Field   | Type | Reset  | Description                                                                                                       |
|------|---------|------|--------|-------------------------------------------------------------------------------------------------------------------|
| 15:0 | OFFSET2 | R/W  | 0x0000 | <b>Channel 2 Conversion Offset</b><br>$f_{\text{OFFSET}_2} = (\text{OFFSET2} \div 2^{16}) \times f_{\text{REF2}}$ |

### 7.6.13 Address 0x0F, OFFSET3 (LDC1314 only)

**Figure 26. Address 0x0F, OFFSET3**

|         |    |    |    |    |    |   |   |
|---------|----|----|----|----|----|---|---|
| 15      | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| OFFSET3 |    |    |    |    |    |   |   |
| 7       | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| OFFSET3 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 12. Address 0x0F, OFFSET3 Field Descriptions**

| Bit  | Field   | Type | Reset  | Description                                                                                                      |
|------|---------|------|--------|------------------------------------------------------------------------------------------------------------------|
| 15:0 | OFFSET3 | R/W  | 0x0000 | <b>Channel 3 Conversion Offset</b><br>$f_{\text{OFFSET3}} = (\text{OFFSET3} \div 2^{16}) \times f_{\text{REF3}}$ |

### 7.6.14 Address 0x10, SETTLECOUNT0

**Figure 27. Address 0x10, SETTLECOUNT0**

|              |    |    |    |    |    |   |   |
|--------------|----|----|----|----|----|---|---|
| 15           | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| SETTLECOUNT0 |    |    |    |    |    |   |   |
| 7            | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| SETTLECOUNT0 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 13. Address 0x10, SETTLECOUNT0 Field Descriptions**

| Bit  | Field        | Type | Reset  | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
|------|--------------|------|--------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:0 | SETTLECOUNT0 | R/W  | 0x0000 | <b>Channel 0 Conversion Settling</b><br>The LDC will use this settling time to allow the LC sensor to stabilize before initiation of a conversion on Channel 0. If the amplitude has not settled prior to the conversion start, an Amplitude error will be generated if reporting of this type of error is enabled.<br>0x0000: Settle Time ( $t_{s0}$ ) = $32 \div f_{\text{REF0}}$<br>0x0001: Settle Time ( $t_{s0}$ ) = $32 \div f_{\text{REF0}}$<br>0x0002 - 0xFFFF: Settle Time ( $t_{s0}$ ) = $(\text{SETTLECOUNT0} \times 16) \div f_{\text{REF0}}$ |

**7.6.15 Address 0x11, SETTLECOUNT1**
**Figure 28. Address 0x11, SETTLECOUNT1**

|              |    |    |    |    |    |   |   |
|--------------|----|----|----|----|----|---|---|
| 15           | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| SETTLECOUNT1 |    |    |    |    |    |   |   |
| 7            | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| SETTLECOUNT1 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 14. Address 0x11, SETTLECOUNT1 Field Descriptions**

| Bit  | Field        | Type | Reset  | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|------|--------------|------|--------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:0 | SETTLECOUNT1 | R/W  | 0x0000 | <b>Channel 1 Conversion Settling</b><br>The LDC will use this settling time to allow the LC sensor to stabilize before initiation of a conversion on a Channel 1. If the amplitude has not settled prior to the conversion start, an Amplitude error will be generated if reporting of this type of error is enabled.<br>0x0000: Settle Time ( $t_{S1}$ ) = $32 \div f_{REF1}$<br>0x0001: Settle Time ( $t_{S1}$ ) = $32 \div f_{REF1}$<br>0x0002 - 0xFFFF: Settle Time ( $t_{S1}$ ) = $(SETTLECOUNT1 \times 16) \div f_{REF1}$ |

**7.6.16 Address 0x12, SETTLECOUNT2 (LDC1314 only)**
**Figure 29. Address 0x12, SETTLECOUNT2**

|              |    |    |    |    |    |   |   |
|--------------|----|----|----|----|----|---|---|
| 15           | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| SETTLECOUNT2 |    |    |    |    |    |   |   |
| 7            | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| SETTLECOUNT2 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 15. Address 0x12, SETTLECOUNT2 Field Descriptions**

| Bit  | Field        | Type | Reset  | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|------|--------------|------|--------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:0 | SETTLECOUNT2 | R/W  | 0x0000 | <b>Channel 2 Conversion Settling</b><br>The LDC will use this settling time to allow the LC sensor to stabilize before initiation of a conversion on Channel 2. If the amplitude has not settled prior to the conversion start, an Amplitude error will be generated if reporting of this type of error is enabled.<br>0x0000: Settle Time ( $t_{S2}$ ) = $32 \div f_{REF2}$<br>0x0001: Settle Time ( $t_{S2}$ ) = $32 \div f_{REF2}$<br>0x0002 - 0xFFFF: Settle Time ( $t_{S2}$ ) = $(SETTLECOUNT2 \times 16) \div f_{REF2}$ |

### 7.6.17 Address 0x13, SETTLECOUNT3 (LDC1314 only)

**Figure 30. Address 0x13, SETTLECOUNT3**

|              |    |    |    |    |    |   |   |
|--------------|----|----|----|----|----|---|---|
| 15           | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| SETTLECOUNT3 |    |    |    |    |    |   |   |
| 7            | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| SETTLECOUNT3 |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 16. Address 0x13, SETTLECOUNT3 Field Descriptions**

| Bit  | Field        | Type | Reset  | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
|------|--------------|------|--------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:0 | SETTLECOUNT3 | R/W  | 0x0000 | <b>Channel 3 Conversion Settling</b><br>The LDC will use this settling time to allow the LC sensor to stabilize before initiation of a conversion on Channel 3. If the amplitude has not settled prior to the conversion start, an Amplitude error will be generated if reporting of this type of error is enabled<br>0x0000: Settle Time ( $t_{S3}$ ) = $32 \div f_{REF3}$<br>0x0001: Settle Time ( $t_{S3}$ ) = $32 \div f_{REF3}$<br>0x0002 - 0xFFFF: Settle Time ( $t_{S3}$ ) = (SETTLECOUNT3*16) $\div f_{REF3}$ |

### 7.6.18 Address 0x14, CLOCK\_DIVIDERS0

**Figure 31. Address 0x14, CLOCK\_DIVIDERS0**

|               |    |    |    |          |    |               |   |
|---------------|----|----|----|----------|----|---------------|---|
| 15            | 14 | 13 | 12 | 11       | 10 | 9             | 8 |
| FIN_DIVIDER0  |    |    |    | RESERVED |    | FREF_DIVIDER0 |   |
| 7             | 6  | 5  | 4  | 3        | 2  | 1             | 0 |
| FREF_DIVIDER0 |    |    |    |          |    |               |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 17. Address 0x14, CLOCK\_DIVIDERS0 Field Descriptions**

| Bit   | Field         | Type | Reset | Description                                                                                                                                                                                                                                                                             |
|-------|---------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:12 | FIN_DIVIDER0  | R/W  | 0000  | <b>Channel 0 Input Divider</b><br>Sets the divider for Channel 0 input. Must be set to $\geq 2$ if the Sensor frequency is $\geq 8.75\text{MHz}$<br>b0000: Reserved. Do not use.<br>$\text{FIN\_DIVIDER0} \geq \text{b0001}$ :<br>$f_{in0} = f_{\text{SENSOR0}} / \text{FIN\_DIVIDER0}$ |
| 11:10 | RESERVED      | R/W  | 00    | Reserved. Set to b00.                                                                                                                                                                                                                                                                   |
| 9:0   | FREF_DIVIDER0 | R/W  | 0x000 | <b>Channel 0 Reference Divider</b><br>Sets the divider for Channel 0 reference. Use this to scale the maximum conversion frequency.<br>0x000: Reserved. Do not use.<br>$\text{FREF\_DIVIDER0} \geq \text{0x001}$ :<br>$f_{REF0} = f_{\text{CLK}} / \text{FREF\_DIVIDER0}$               |

**7.6.19 Address 0x15, CLOCK\_DIVIDERS1**
**Figure 32. Address 0x15, CLOCK\_DIVIDERS1**

|               |    |    |    |          |    |               |   |
|---------------|----|----|----|----------|----|---------------|---|
| 15            | 14 | 13 | 12 | 11       | 10 | 9             | 8 |
| FIN_DIVIDER1  |    |    |    | RESERVED |    | FREF_DIVIDER1 |   |
| 7             | 6  | 5  | 4  | 3        | 2  | 1             | 0 |
| FREF_DIVIDER1 |    |    |    |          |    |               |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 18. Address 0x15, CLOCK\_DIVIDERS1 Field Descriptions**

| Bit   | Field         | Type | Reset | Description                                                                                                                                                                                                                                                 |
|-------|---------------|------|-------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:12 | FIN_DIVIDER1  | R/W  | 0000  | <b>Channel 1 Input Divider</b><br>Sets the divider for Channel 1 input. Used when the Sensor frequency is greater than the maximum $F_{IN}$ .<br>b0000: Reserved. Do not use.<br>$FIN\_DIVIDER1 \geq b0001$ :<br>$f_{in1} = f_{SENSOR1} \div FIN\_DIVIDER1$ |
| 11:10 | RESERVED      | R/W  | 00    | Reserved. Set to b00.                                                                                                                                                                                                                                       |
| 9:0   | FREF_DIVIDER1 | R/W  | 0x000 | <b>Channel 1 Reference Divider</b><br>Sets the divider for Channel 1 reference. Use this to scale the maximum conversion frequency.<br>0x000: Reserved. Do not use.<br>$FREF\_DIVIDER1 \geq 0x001$ :<br>$f_{REF1} = f_{CLK} \div FREF\_DIVIDER1$            |

**7.6.20 Address 0x16, CLOCK\_DIVIDERS2 (LDC1314 only)**
**Figure 33. Address 0x16, CLOCK\_DIVIDERS2**

|               |    |    |    |          |    |               |   |
|---------------|----|----|----|----------|----|---------------|---|
| 15            | 14 | 13 | 12 | 11       | 10 | 9             | 8 |
| FIN_DIVIDER2  |    |    |    | RESERVED |    | FREF_DIVIDER2 |   |
| 7             | 6  | 5  | 4  | 3        | 2  | 1             | 0 |
| FREF_DIVIDER2 |    |    |    |          |    |               |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 19. Address 0x16, CLOCK\_DIVIDERS2 Field Descriptions**

| Bit   | Field         | Type | Reset | Description                                                                                                                                                                                                                                                      |
|-------|---------------|------|-------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:12 | FIN_DIVIDER2  | R/W  | 0000  | <b>Channel 2 Input Divider</b><br>Sets the divider for Channel 2 input. Must be set to $\geq 2$ if the Sensor frequency is $\geq 8.75\text{MHz}$ .<br>b0000: Reserved. Do not use.<br>$FIN\_DIVIDER2 \geq b0001$ :<br>$f_{IN2} = f_{SENSOR2} \div FIN\_DIVIDER2$ |
| 11:10 | RESERVED      | R/W  | 00    | Reserved. Set to b00.                                                                                                                                                                                                                                            |
| 9:0   | FREF_DIVIDER2 | R/W  | 0x000 | <b>Channel 2 Reference Divider</b><br>Sets the divider for Channel 2 reference. Use this to scale the maximum conversion frequency.<br>0x000: Reserved. Do not use.<br>$FREF\_DIVIDER2 \geq 0x001$ :<br>$f_{REF2} = f_{CLK} \div FREF\_DIVIDER2$                 |

## 7.6.21 Address 0x17, CLOCK\_DIVIDERS3 (LDC1314 only)

**Figure 34. Address 0x17, CLOCK\_DIVIDERS3**

|               |    |    |    |          |    |               |   |
|---------------|----|----|----|----------|----|---------------|---|
| 15            | 14 | 13 | 12 | 11       | 10 | 9             | 8 |
| FIN_DIVIDER3  |    |    |    | RESERVED |    | FREF_DIVIDER3 |   |
| 7             | 6  | 5  | 4  | 3        | 2  | 1             | 0 |
| FREF_DIVIDER3 |    |    |    |          |    |               |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 20. Address 0x17, CLOCK\_DIVIDERS3**

| Bit   | Field         | Type | Reset | Description                                                                                                                                                                                                                                                                                         |
|-------|---------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:12 | FIN_DIVIDER3  | R/W  | 0000  | <b>Channel 3 Input Divider</b><br>Sets the divider for Channel 3 input. Must be set to $\geq 2$ if the Sensor frequency is $\geq 8.75\text{MHz}$ .<br>b0000: Reserved. Do not use.<br>$\text{FIN\_DIVIDER3} \geq \text{b0001}$ :<br>$f_{\text{IN3}} = f_{\text{SENSOR3}} \div \text{FIN\_DIVIDER3}$ |
| 11:10 | RESERVED      | R/W  | 00    | Reserved. Set to b00.                                                                                                                                                                                                                                                                               |
| 9:0   | FREF_DIVIDER3 | R/W  | 0x000 | <b>Channel 3 Reference Divider</b><br>Sets the divider for Channel 3 reference. Use this to scale the maximum conversion frequency.<br>0x000: reserved<br>$\text{FREF\_DIVIDER3} \geq \text{0x001}$ :<br>$f_{\text{REF3}} = f_{\text{CLK}} \div \text{FREF\_DIVIDER3}$                              |

## 7.6.22 Address 0x18, STATUS

**Figure 35. Address 0x18, STATUS**

|          |      |          |        |                 |                 |                 |                 |
|----------|------|----------|--------|-----------------|-----------------|-----------------|-----------------|
| 15       | 14   | 13       | 12     | 11              | 10              | 9               | 8               |
| ERR_CHAN |      | ERR_UR   | ERR_OR | ERR_WD          | ERR_AHE         | ERR_ALE         | ERR_ZC          |
| 7        | 6    | 5        | 4      | 3               | 2               | 1               | 0               |
| RESERVED | DRDY | RESERVED |        | UNREADCON<br>V0 | UNREADCONV<br>1 | UNREADCONV<br>2 | UNREADCONV<br>3 |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 21. Address 0x18, STATUS Field Descriptions**

| Bit   | Field    | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                                                                        |
|-------|----------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:14 | ERR_CHAN | R    | 00    | <b>Error Channel</b><br>Indicates which channel has generated a Flag or Error. Once flagged, any reported error is latched and maintained until either the STATUS register or the DATAx register corresponding to the Error Channel is read.<br>b00: Channel 0 is source of flag or error.<br>b01: Channel 1 is source of flag or error.<br>b10: Channel 2 is source of flag or error (LDC1314 only).<br>b11: Channel 3 is source of flag or error (LDC1314 only). |
| 13    | ERR_UR   | R    | 0     | <b>Conversion Under-range Error</b><br>b0: No Conversion Under-range error was recorded since the last read of the STATUS register.<br>b1: An active channel has generated a Conversion Under-range error. Refer to STATUS.ERR_CHAN field to determine which channel is the source of this error.                                                                                                                                                                  |
| 12    | ERR_OR   | R    | 0     | <b>Conversion Over-range Error</b><br>b0: No Conversion Over-range error was recorded since the last read of the STATUS register.<br>b1: An active channel has generated a Conversion Over-range error. Refer to STATUS.ERR_CHAN field to determine which channel is the source of this error.                                                                                                                                                                     |

**Table 21. Address 0x18, STATUS Field Descriptions (continued)**

| Bit | Field       | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                              |
|-----|-------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 11  | ERR_WD      | R    | 0     | <b>Watchdog Timeout Error</b><br>b0: No Watchdog Timeout error was recorded since the last read of the STATUS register.<br>b1: An active channel has generated a Watchdog Timeout error. Refer to STATUS.ERR_CHAN field to determine which channel is the source of this error.                                                                                                                                          |
| 10  | ERR_AHE     | R    | 0     | <b>Sensor Amplitude High Error</b><br>b0: No Amplitude High error was recorded since the last read of the STATUS register.<br>b1: An active channel has generated an Amplitude High error - this occurs when the sensor amplitude is above a nominal 1.8 V. It is recommended to reduce the corresponding sensor IDRIVEx setting. Refer to STATUS.ERR_CHAN field to determine which channel is the source of this error. |
| 9   | ERR_ALE     | R    | 0     | <b>Sensor Amplitude Low Error</b><br>b0: No Amplitude Low error was recorded since the last read of the STATUS register.<br>b1: An active channel has generated an Amplitude Low error - this occurs when the sensor amplitude is below a nominal 1.2 V. Refer to STATUS.ERR_CHAN field to determine which channel is the source of this error.                                                                          |
| 8   | ERR_ZC      | R    | 0     | <b>Zero Count Error</b><br>b0: No Zero Count error was recorded since the last read of the STATUS register.<br>b1: An active channel has generated a Zero Count error. Refer to STATUS.ERR_CHAN field to determine which channel is the source of this error.                                                                                                                                                            |
| 7   | Reserved    | R    | 0     | Reserved. Reads 0.                                                                                                                                                                                                                                                                                                                                                                                                       |
| 6   | DRDY        | R    | 0     | <b>Data Ready Flag</b><br>b0: No new conversion result was recorded in the STATUS register.<br>b1: A new conversion result is ready. When in Single Channel Conversion, this indicates a single conversion is available. When in sequential mode, this indicates that a new conversion result for all active channels is now available.                                                                                  |
| 5:4 | Reserved    | R    | 00    | Reserved. Reads 00b.                                                                                                                                                                                                                                                                                                                                                                                                     |
| 3   | UNREADCONV0 | R    | 0     | <b>Channel 0 Unread Conversion</b><br>b0: No unread conversion is present for Channel 0.<br>b1: An unread conversion is present for Channel 0. Read Register DATA0 to retrieve conversion results.                                                                                                                                                                                                                       |
| 2   | UNREADCONV1 | R    | 0     | <b>Channel 1 Unread Conversion</b><br>b0: No unread conversion is present for Channel 1.<br>b1: An unread conversion is present for Channel 1. Read Register DATA1 to retrieve conversion results.                                                                                                                                                                                                                       |
| 1   | UNREADCONV2 | R    | 0     | <b>Channel 2 Unread Conversion</b><br>b0: No unread conversion is present for Channel 2.<br>b1: An unread conversion is present for Channel 2. Read Register DATA2 to retrieve conversion results (LDC1314 only)                                                                                                                                                                                                         |
| 0   | UNREADCONV3 | R    | 0     | <b>Channel 3 Unread Conversion</b><br>b0: No unread conversion is present for Channel 3.<br>b1: An unread conversion is present for Channel 3. Read Register DATA3 to retrieve conversion results (LDC1314 only)                                                                                                                                                                                                         |

## 7.6.23 Address 0x19, ERROR\_CONFIG

**Figure 36. Address 0x19, ERROR\_CONFIG**

| 15         | 14         | 13         | 12         | 11         | 10         | 9        | 8         |
|------------|------------|------------|------------|------------|------------|----------|-----------|
| UR_ERR2OUT | OR_ERR2OUT | WD_ERR2OUT | AH_ERR2OUT | AL_ERR2OUT | RESERVED   |          |           |
| 7          | 6          | 5          | 4          | 3          | 2          | 1        | 0         |
| UR_ERR2INT | OR_ERR2INT | WD_ERR2INT | AH_ERR2INT | AL_ERR2INT | ZC_ERR2INT | Reserved | DRDY_2INT |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 22. Address 0x19, ERROR\_CONFIG**

| Bit  | Field      | Type | Reset | Description                                                                                                                                                                                                                                            |
|------|------------|------|-------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15   | UR_ERR2OUT | R/W  | 0     | <b>Under-range Error to Output Register</b><br>b0: Do not report Under-range errors in the DATAx registers.<br>b1: Report Under-range errors in the DATAx.ERR_URx register field corresponding to the channel that generated the error.                |
| 14   | OR_ERR2OUT | R/W  | 0     | <b>Over-range Error to Output Register</b><br>b0: Do not report Over-range errors in the DATAx registers.<br>b1: Report Over-range errors in the DATAx.ERR_ORx register field corresponding to the channel that generated the error.                   |
| 13   | WD_ERR2OUT | R/W  | 0     | <b>Watchdog Timeout Error to Output Register</b><br>b0: Do not report Watchdog Timeout errors in the DATAx registers.<br>b1: Report Watchdog Timeout errors in the DATAx.ERR_WDx register field corresponding to the channel that generated the error. |
| 12   | AH_ERR2OUT | R/W  | 0     | <b>Amplitude High Error to Output Register</b><br>b0: Do not report Amplitude High errors in the DATAx registers.<br>b1: Report Amplitude High errors in the DATAx.ERR_AEx register field corresponding to the channel that generated the error.       |
| 11   | AL_ERR2OUT | R/W  | 0     | <b>Amplitude Low Error to Output Register</b><br>b0: Do not report Amplitude High errors in the DATAx registers.<br>b1: Report Amplitude High errors in the DATAx.ERR_AEx register field corresponding to the channel that generated the error.        |
| 10:8 | Reserved   | R/W  | 00    | Reserved. Set to b00.                                                                                                                                                                                                                                  |
| 7    | UR_ERR2INT | R/W  | 0     | <b>Under-range Error to INTB</b><br>b0: Do not report Under-range errors by asserting INTB pin and STATUS register.<br>b1: Report Under-range errors by asserting INTB pin and updating STATUS.ERR_UR register field.                                  |
| 6    | OR_ERR2INT | R/W  | 0     | <b>Over-range Error to INTB</b><br>b0: Do not report Over-range errors by asserting INTB pin and STATUS register.<br>b1: Report Over-range errors by asserting INTB pin and updating STATUS.ERR_OR register field.                                     |
| 5    | WD_ERR2INT | R/W  | 0     | <b>Watchdog Timeout Error to INTB</b><br>b0: Do not report Watchdog errors by asserting INTB pin and STATUS register.<br>b1: Report Watchdog Timeout errors by asserting INTB pin and updating STATUS.ERR_WD register field.                           |
| 4    | AH_ERR2INT | R/W  | 0     | <b>Amplitude High Error to INTB</b><br>b0: Do not report Amplitude High errors by asserting INTB pin and STATUS register.<br>b1: Report Amplitude High errors by asserting INTB pin and updating STATUS.ERR_AHE register field.                        |
| 3    | AL_ERR2INT | R/W  | 0     | <b>Amplitude Low Error to INTB</b><br>b0: Do not report Amplitude Low errors by asserting INTB pin and STATUS register.<br>b1: Report Amplitude Low errors by asserting INTB pin and updating STATUS.ERR_ALE register field.                           |

**Table 22. Address 0x19, ERROR\_CONFIG (continued)**

| Bit | Field      | Type | Reset | Description                                                                                                                                                                                                         |
|-----|------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 2   | ZC_ERR2INT | R/W  | 0     | <b>Zero Count Error to INTB</b><br>b0: Do not report Zero Count errors by asserting INTB pin and STATUS register.<br>b1: Report Zero Count errors by asserting INTB pin and updating STATUS. ERR_ZC register field. |
| 1   | Reserved   | R/W  | 0     | Reserved. Set to b0.                                                                                                                                                                                                |
| 0   | DRDY_2INT  | R/W  | 0     | <b>Data Ready Flag to INTB</b><br>b0: Do not report Data Ready Flag by asserting INTB pin and STATUS register.<br>b1: Report Data Ready Flag by asserting INTB pin and updating STATUS. DRDY register field.        |

## 7.6.24 Address 0x1A, CONFIG

**Figure 37. Address 0x1A, CONFIG**

|             |                  |               |                |                     |              |             |          |
|-------------|------------------|---------------|----------------|---------------------|--------------|-------------|----------|
| 15          | 14               | 13            | 12             | 11                  | 10           | 9           | 8        |
| ACTIVE_CHAN |                  | SLEEP_MODE_EN | RP_OVERRIDE_EN | SENSOR_ACTIVATE_SEL | AUTO_AMP_DIS | REF_CLK_SRC | RESERVED |
| 7           | 6                | 5             | 4              | 3                   | 2            | 1           | 0        |
| INTB_DIS    | HIGH_CURRENT_DRV | RESERVED      |                |                     |              |             |          |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 23. Address 0x1A, CONFIG Field Descriptions**

| Bit   | Field               | Type | Reset | Description                                                                                                                                                                                                                                                                                                                                                                                                     |
|-------|---------------------|------|-------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:14 | ACTIVE_CHAN         | R/W  | 00    | <b>Active Channel Selection</b><br>Selects channel for continuous conversions when MUX_CONFIG.AUTOSCAN_EN is 0.<br>b00: Perform continuous conversions on Channel 0<br>b01: Perform continuous conversions on Channel 1<br>b10: Perform continuous conversions on Channel 2 (LDC1314 only)<br>b11: Perform continuous conversions on Channel 3 (LDC1314 only)                                                   |
| 13    | SLEEP_MODE_EN       | R/W  | 1     | <b>Sleep Mode Enable</b><br>Enter or exit low power Sleep Mode.<br>b0: Device is active.<br>b1: Device is in Sleep Mode.                                                                                                                                                                                                                                                                                        |
| 12    | RP_OVERRIDE_EN      | R/W  | 0     | <b>Sensor R<sub>p</sub> Override Enable</b><br>Provides control over Sensor current drive used during the conversion time for Ch. x, based on the programmed value in the IDRIVEx field. Refer to <a href="#">Automatic IDRIVE Setting with RP_OVERRIDE_EN</a> for details.<br>b0: Override off<br>b1: R <sub>p</sub> Override on                                                                               |
| 11    | SENSOR_ACTIVATE_SEL | R/W  | 1     | <b>Sensor Activation Mode Selection</b><br>Set the mode for sensor initialization. Refer to <a href="#">Sensor Activation</a> for details.<br>b0: Full Current Activation Mode – the LDC will drive maximum sensor current for a shorter sensor activation time.<br>b1: Low Power Activation Mode – the LDC uses the value programmed in DRIVE_CURRENTx during sensor activation to minimize power consumption. |
| 10    | AUTO_AMP_DIS        | R/W  | 0     | <b>Automatic Sensor Amplitude Correction Disable</b><br>Setting this bit will disable the automatic Amplitude correction algorithm and stop the updating of the INIT_IDRIVEx field.<br>b0: Automatic Amplitude correction enabled.<br>b1: Automatic Amplitude correction is disabled. Recommended for precision applications.                                                                                   |

**Table 23. Address 0x1A, CONFIG Field Descriptions (continued)**

| Bit | Field            | Type | Reset   | Description                                                                                                                                                                                                                                   |
|-----|------------------|------|---------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 9   | REF_CLK_SRC      | R/W  | 0       | <b>Select Reference Frequency Source</b><br>b0: Use Internal oscillator as reference frequency.<br>b1: Reference frequency is provided from CLKIN pin.                                                                                        |
| 8   | RESERVED         | R/W  | 0       | Reserved. Set to b0.                                                                                                                                                                                                                          |
| 7   | INTB_DIS         | R/W  | 0       | <b>INTB Disable</b><br>b0: INTB pin will be asserted when status register updates.<br>b1: INTB pin will not be asserted when status register updates. If this mode is selected, the INTB pin level will be high.                              |
| 6   | HIGH_CURRENT_DRV | R/W  | 0       | <b>High Current Sensor Drive</b><br>b0: The LDC will drive all channels with normal sensor current (1.5mA max).<br>b1: The LDC will drive channel 0 with current >1.5mA. This mode is not supported if AUTOSCAN_EN = b1 (multi-channel mode). |
| 5:0 | RESERVED         | R/W  | 00 0001 | Reserved. Set to b00'0001.                                                                                                                                                                                                                    |

### 7.6.25 Address 0x1B, MUX\_CONFIG

**Figure 38. Address 0x1B, MUX\_CONFIG**

|             |             |    |          |    |          |   |   |
|-------------|-------------|----|----------|----|----------|---|---|
| 15          | 14          | 13 | 12       | 11 | 10       | 9 | 8 |
| AUTOSCAN_EN | RR_SEQUENCE |    | RESERVED |    |          |   |   |
| 7           | 6           | 5  | 4        | 3  | 2        | 1 | 0 |
| RESERVED    |             |    |          |    | DEGLITCH |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 24. Address 0x1B, MUX\_CONFIG Field Descriptions**

| Bit   | Field       | Type | Reset        | Description                                                                                                                                                                                                                                                                                                                         |
|-------|-------------|------|--------------|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15    | AUTOSCAN_EN | R/W  | 0            | <b>Auto-Scan Mode Enable</b><br>b0: Continuous conversion on the single channel selected by CONFIG.ACTIVE_CHAN register field.<br>b1: Auto-Scan conversions as selected by MUX_CONFIG.RR_SEQUENCE register field.                                                                                                                   |
| 14:13 | RR_SEQUENCE | R/W  | 00           | <b>Auto-Scan Sequence Configuration</b><br>Configure multiplexing channel sequence. The LDC will perform a single conversion on each channel in the sequence selected, and then restart the sequence continuously.<br>b00: Ch0, Ch1<br>b01: Ch0, Ch1, Ch2 (LDC1314 only)<br>b10: Ch0, Ch1, Ch2, Ch3 (LDC1314 only)<br>b11: Ch0, Ch1 |
| 12:3  | RESERVED    | R/W  | 00 0100 0001 | Reserved. Set to 00 0100 0001.                                                                                                                                                                                                                                                                                                      |
| 2:0   | DEGLITCH    | R/W  | 111          | <b>Input Deglitch Filter Bandwidth</b><br>Select the lowest setting that exceeds the maximum sensor oscillation frequency.<br>b001: 1.0 MHz<br>b100: 3.3 MHz<br>b101: 10 MHz<br>b111: 33 MHz                                                                                                                                        |

### 7.6.26 Address 0x1C, RESET\_DEV

**Figure 39. Address 0x1C, RESET\_DEV**

|           |          |    |    |    |             |   |          |
|-----------|----------|----|----|----|-------------|---|----------|
| 15        | 14       | 13 | 12 | 11 | 10          | 9 | 8        |
| RESET_DEV | RESERVED |    |    |    | OUTPUT_GAIN |   | RESERVED |
| 7         | 6        | 5  | 4  | 3  | 2           | 1 | 0        |
| RESERVED  |          |    |    |    |             |   |          |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 25. Address 0x1C, RESET\_DEV Field Descriptions**

| Bit   | Field       | Type | Reset | Description                                                                                                                                             |
|-------|-------------|------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15    | RESET_DEV   | R/W  | 0     | <b>Device Reset</b><br>Write b1 to reset the device. Will always readback 0.                                                                            |
| 14:11 | RESERVED    | R/W  | 0000  | Reserved. Set to b0000.                                                                                                                                 |
| 10:9  | OUTPUT_GAIN | R/W  | 00    | <b>Output Gain Control</b><br>00: Gain = 1 (0 bits shift)<br>01: Gain = 4 (2 bits shift)<br>10: Gain = 8 (3 bits shift)<br>11: Gain = 16 (4 bits shift) |
| 8:0   | RESERVED    | R/W  | 0x000 | Reserved. Set to b0 0000 0000.                                                                                                                          |

### 7.6.27 Address 0x1E, DRIVE\_CURRENT0

**Figure 40. Address 0x1E, DRIVE\_CURRENT0**

|              |    |          |    |    |              |   |   |
|--------------|----|----------|----|----|--------------|---|---|
| 15           | 14 | 13       | 12 | 11 | 10           | 9 | 8 |
| IDRIVE0      |    |          |    |    | INIT_IDRIVE0 |   |   |
| 7            | 6  | 5        | 4  | 3  | 2            | 1 | 0 |
| INIT_IDRIVE0 |    | RESERVED |    |    |              |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 26. Address 0x1E, DRIVE\_CURRENT0 Field Descriptions**

| Bit   | Field        | Type | Reset   | Description                                                                                                                                                                                                                                                                                              |
|-------|--------------|------|---------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:11 | IDRIVE0      | R/W  | 0 0000  | <b>Channel 0 L-C Sensor Drive Current</b><br>This field sets the Sensor Drive Current used during the settling + conversion time of Channel 0 sensor. RP_OVERRIDE_EN bit must be set to 1.                                                                                                               |
| 10:6  | INIT_IDRIVE0 | R    | 0 0000  | <b>Channel 0 Sensor Current Drive</b><br>This field stores the Initial Drive Current measured during the initial Amplitude Calibration phase. It is updated after each Amplitude Correction phase of the sensor conversion if AUTO_AMP_DIS=0. When writing to DRIVE_CURRENT0, set this field to b0 0000. |
| 5:0   | RESERVED     | R/W  | 00 0000 | Reserved. Set to b00 0000                                                                                                                                                                                                                                                                                |

## 7.6.28 Address 0x1F, DRIVE\_CURRENT1

**Figure 41. Address 0x1F, DRIVE\_CURRENT1**

|              |    |          |    |    |              |   |   |
|--------------|----|----------|----|----|--------------|---|---|
| 15           | 14 | 13       | 12 | 11 | 10           | 9 | 8 |
| IDRIVE1      |    |          |    |    | INIT_IDRIVE1 |   |   |
| 7            | 6  | 5        | 4  | 3  | 2            | 1 | 0 |
| INIT_IDRIVE1 |    | RESERVED |    |    |              |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 27. Address 0x1F, DRIVE\_CURRENT1 Field Descriptions**

| Bit   | Field        | Type | Reset   | Description                                                                                                                                                                                                                                                                                                   |
|-------|--------------|------|---------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:11 | IDRIVE1      | R/W  | 0 0000  | <b>Channel 1 L-C Sensor Drive Current</b><br>This field sets the Sensor Drive Current used during the settling + conversion time of Channel 0 sensor.<br>RP_OVERRIDE_EN bit must be set to 1.                                                                                                                 |
| 10:6  | INIT_IDRIVE1 | R    | 0 0000  | <b>Channel 1 Sensor Current Drive</b><br>This field stores the Initial Drive Current calculated during the initial Amplitude Calibration phase. It is updated after each Amplitude Correction phase of the sensor conversion if AUTO_AMP_DIS=0.<br>When writing to DRIVE_CURRENT1, set this field to b0 0000. |
| 5:0   | RESERVED     | -    | 00 0000 | Reserved                                                                                                                                                                                                                                                                                                      |

## 7.6.29 Address 0x20, DRIVE\_CURRENT2 (LDC1314 only)

**Figure 42. Address 0x20, DRIVE\_CURRENT2**

|              |    |          |    |    |              |   |   |
|--------------|----|----------|----|----|--------------|---|---|
| 15           | 14 | 13       | 12 | 11 | 10           | 9 | 8 |
| IDRIVE2      |    |          |    |    | INIT_IDRIVE2 |   |   |
| 7            | 6  | 5        | 4  | 3  | 2            | 1 | 0 |
| INIT_IDRIVE2 |    | RESERVED |    |    |              |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 28. Address 0x20, DRIVE\_CURRENT2 Field Descriptions**

| Bit   | Field        | Type | Reset   | Description                                                                                                                                                                                                                                                                                                   |
|-------|--------------|------|---------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:11 | IDRIVE2      | R/W  | 0 0000  | <b>Channel 2 L-C Sensor Drive Current</b><br>This field sets the Sensor Drive Current used during the settling + conversion time of Channel 0 sensor.<br>RP_OVERRIDE_EN bit must be set to 1.                                                                                                                 |
| 10:6  | INIT_IDRIVE2 | R    | 0 0000  | <b>Channel 2 Sensor Current Drive</b><br>This field stores the Initial Drive Current calculated during the initial Amplitude Calibration phase. It is updated after each Amplitude Correction phase of the sensor conversion if AUTO_AMP_DIS=0.<br>When writing to DRIVE_CURRENT2, set this field to b0 0000. |
| 5:0   | RESERVED     | –    | 00 0000 | Reserved                                                                                                                                                                                                                                                                                                      |

**7.6.30 Address 0x21, DRIVE\_CURRENT3 (LDC1314 only)**
**Figure 43. Address 0x21, DRIVE\_CURRENT3**

|              |    |          |    |    |    |              |   |
|--------------|----|----------|----|----|----|--------------|---|
| 15           | 14 | 13       | 12 | 11 | 10 | 9            | 8 |
| IDRIVE3      |    |          |    |    |    | INIT_IDRIVE3 |   |
| 7            | 6  | 5        | 4  | 3  | 2  | 1            | 0 |
| INIT_IDRIVE3 |    | RESERVED |    |    |    |              |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 29. DRIVE\_CURRENT3 Field Descriptions**

| Bit   | Field        | Type | Reset   | Description                                                                                                                                                                                                                                                                                                  |
|-------|--------------|------|---------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 15:11 | IDRIVE3      | R/W  | 0 0000  | <b>Channel 3 L-C Sensor Drive Current</b><br>This field sets the Sensor Drive Current used during the settling + conversion time of Channel 0 sensor. RP_OVERRIDE_EN bit must be set to 1.                                                                                                                   |
| 10:6  | INIT_IDRIVE3 | R    | 0 0000  | <b>Channel 3 Sensor Current Drive</b><br>This field stores the Initial Drive Current calculated during the initial Amplitude Calibration phase. It is updated after each Amplitude Correction phase of the sensor conversion if AUTO_AMP_DIS = 0. When writing to DRIVE_CURRENT3, set this field to b0 0000. |
| 5:0   | RESERVED     | –    | 00 0000 | Reserved                                                                                                                                                                                                                                                                                                     |

**7.6.31 Address 0x7E, MANUFACTURER\_ID**
**Table 30. Address 0x7E, MANUFACTURER\_ID Field Descriptions**

| Bit  | Field           | Type | Reset                  | Description              |
|------|-----------------|------|------------------------|--------------------------|
| 15:0 | MANUFACTURER_ID | R    | 0101 0100<br>0100 1001 | Manufacturer ID = 0x5449 |

**7.6.32 Address 0x7F, DEVICE\_ID**
**Figure 44. Address 0x7F, DEVICE\_ID**

|           |    |    |    |    |    |   |   |
|-----------|----|----|----|----|----|---|---|
| 15        | 14 | 13 | 12 | 11 | 10 | 9 | 8 |
| DEVICE_ID |    |    |    |    |    |   |   |
| 7         | 6  | 5  | 4  | 3  | 2  | 1 | 0 |
| DEVICE_ID |    |    |    |    |    |   |   |

LEGEND: R/W = Read/Write; R = Read only; -n = value after reset

**Table 31. Address 0x7F, DEVICE\_ID Field Descriptions**

| Bit | Field     | Type | Reset                  | Description        |
|-----|-----------|------|------------------------|--------------------|
| 7:0 | DEVICE_ID | R    | 0011 0000<br>0101 0100 | Device ID = 0x3054 |

## 8 Application and Implementation

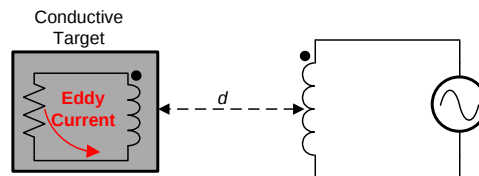
### NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

### 8.1 Application Information

#### 8.1.1 Conductive Objects in a Time-Varying EM Field

An AC current flowing through an inductor will generate an AC magnetic field. If a conductive material, such as a metal object, is brought into the vicinity of the inductor, the magnetic field will induce a circulating current (eddy current) on the surface of the conductor.

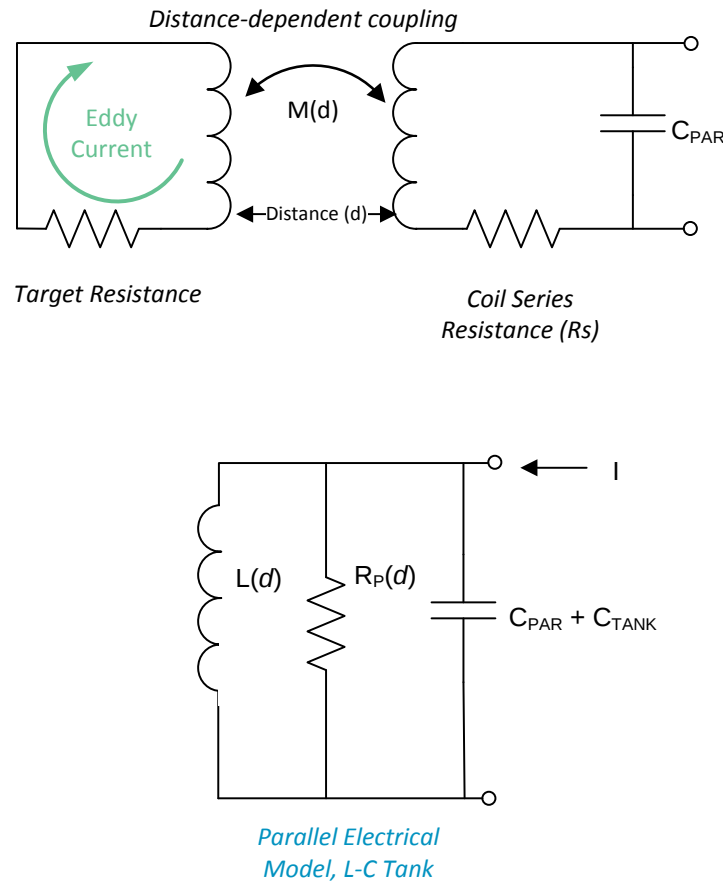


**Figure 45. Conductor in AC Magnetic Field**

The eddy current is a function of the distance, size, and composition of the conductor. The eddy current generates its own magnetic field, which opposes the original field generated by the sensor inductor. This effect is equivalent to a set of coupled inductors, where the sensor inductor is the primary winding and the eddy current in the target object represents the secondary inductor. The coupling between the inductors is a function of the sensor inductor, and the resistivity, distance, size, and shape of the conductive target. The resistance and inductance of the secondary winding caused by the eddy current can be modeled as a distance dependent resistive and inductive component on the primary side (coil). [Figure 45](#) shows a simplified circuit model of the sensor and the target as coupled coils.

#### 8.1.2 L-C Resonators

An EM field can be generated using an L-C resonator, or L-C tank. One topology for an L-C tank is a parallel R-L-C construction, as shown in [Figure 46](#).

**Application Information (continued)**


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**Figure 46. Electrical Model of the L-C Tank Sensor**

A resonant oscillator can be constructed by combining a frequency selective circuit (resonator) with a gain block in a closed loop. The criteria for oscillation are: (1) loop gain > 1, and (2) closed loop phase shift of  $2\pi$  radians. The R-L-C resonator provides the frequency selectivity and contributes to the phase shift. At the resonance frequency, the impedance of the reactive components (L and C) cancels, leaving only  $R_P$ , the lossy (resistive) element in the circuit. The voltage amplitude is maximized at this frequency. The  $R_P$  can be used to determine the sensor drive current for a given oscillation amplitude. A lower  $R_P$  requires a larger sensor current to maintain a constant oscillation amplitude. The sensor oscillation frequency is given by:

$$f_{\text{SENSOR}} = \frac{1}{2\pi\sqrt{LC}} * \sqrt{1 - \frac{1}{Q^2} - \frac{5 \cdot 10^{-9}}{Q\sqrt{LC}}} \approx \frac{1}{2\pi\sqrt{LC}}$$

where:

- C is the sensor capacitance ( $C_{\text{SENSOR}} + C_{\text{PARASITIC}}$ )
- L is the sensor inductance

(1)

The value of Q can be calculated by:

$$Q = R_P \sqrt{\frac{C}{L}}$$

where:

- $R_P$  is the AC parallel resistance of the LC resonator at the operating frequency

(2)

## Application Information (continued)

Texas Instruments' WEBENCH design tool can be used for coil design, in which the parameter values for  $R_p$ ,  $L$  and  $C$  are calculated. See <http://www.ti.com/webench>.

$R_p$  is a function of target distance, target material, and sensor characteristics. Figure 47 shows an example of  $R_p$  variation based on the distance between the sensor and the target. The graph represents a 14 mm diameter PCB coil (23 turns, 4 mil trace width, 4 mil spacing between traces, 1 oz. copper thickness, on FR4 material). This curve is a typical response where the target distance scales based on the sensor size and the sensor  $R_p$  scales based on the free-space of the inductor.



**Figure 47. Example  $R_p$  vs. Distance with a 14 mm PCB Coil and 2 mm Thick Stainless Steel Target**

It is important to configure the sensor current drive so that the sensor will still oscillate at the minimum  $R_p$  value (which typically occurs with maximum target interaction). As an example, if the closest target distance in a system with the response shown in Figure 47 is 1mm, then the sensor current drive needs to support a  $R_p$  value is 5 kΩ. Both the minimum and maximum  $R_p$  conditions should have oscillation amplitudes that are within the device operating range. See section [Sensor Current Drive Control](#) for details on setting the current drive.

The inductance that is measured by the LDC is:

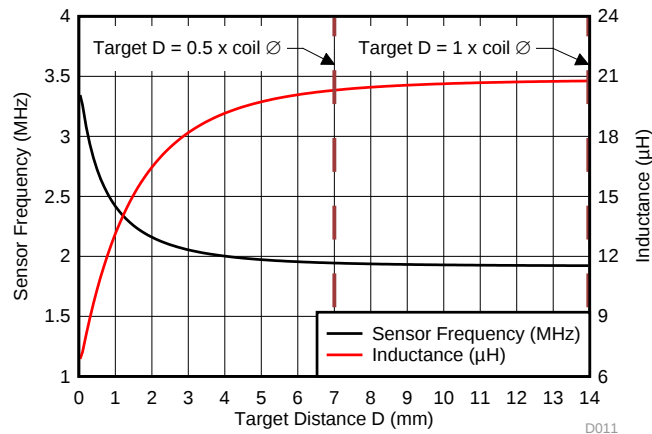
$$L(d) = L_{inf} - M(d) = \frac{1}{(2\pi * f_{SENSOR})^2 * C}$$

where:

- $L(d)$  is the measured sensor inductance, for a distance  $d$  between the sensor coil and target
- $L_{inf}$  is the inductance of the sensing coil without a conductive target (target at infinite distance)
- $M(d)$  is the mutual inductance
- $f_{SENSOR}$  = sensor oscillation frequency for a distance  $d$  between the sensor coil and target
- $C = C_{SENSOR} + C_{PARASITIC}$  (3)

Figure 48 shows an example of variation in sensor frequency and inductance as a function of distance for a 14 mm diameter PCB coil (23 turns, 4 mil trace width, 4 mil spacing between traces, 1 oz copper thickness, FR4 material). The frequency and inductance graphs will scale based on the sensor free-space characteristics, and the target distance scales based on the sensor diameter.

## Application Information (continued)



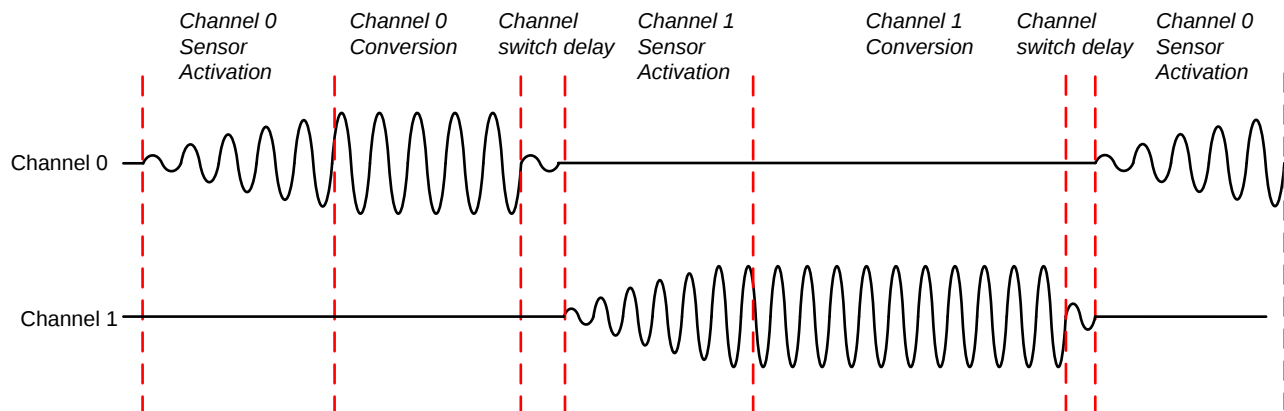
**Figure 48. Example Sensor Frequency, Inductance vs. Target Distance with 14 mm PCB Coil and 1.5 mm Thick Aluminum Target**

The Texas Instruments Application Notes [LDC Sensor Design](#) and [LDC Target Design](#) provide more information on construction of sensors and targets characteristics to consider based on system requirements.

### 8.1.3 Multi-Channel and Single Channel Operation

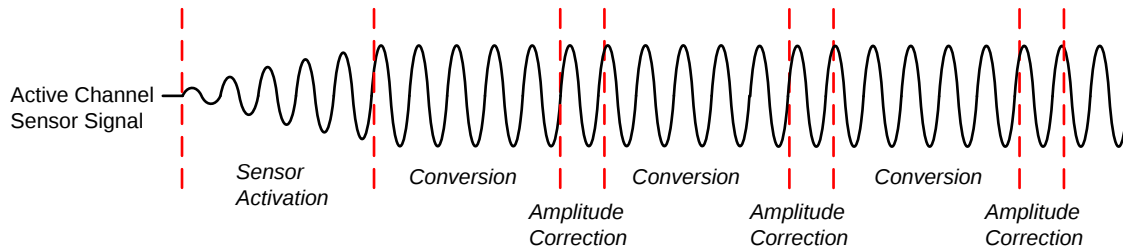
The multi-channel package of the LDC enables the user to save board space and support flexible system design. For example, temperature drift can often cause a shift in component values, resulting in a shift in resonant frequency of the sensor. Using a second sensor as a reference or in a differential configuration provides the capability to cancel out temperature shifts and other environmental variations. When operated in multi-channel mode, the LDC sequentially samples the selected channels - only one channel is active at any time while the other selected channels are held in an inactive state. In single channel mode, the LDC samples a single channel, which is selectable. Refer to [Inactive Channel Sensor Connections](#) for more details on inactive channels.

Inactive channels have the corresponding INAx and INBx pins tied to ground. The following table shows the registers and values that are used to configure either multi-channel or single channel modes.



**Figure 49. Multi-Channel Mode Sequencing**

## Application Information (continued)



**Figure 50. Single-Channel Mode Sequencing**

**Table 32. Single and Multi-Channel Configuration Registers**

| MODE           | REGISTER             | FIELD               | VALUE <sup>(1)</sup>                                              |
|----------------|----------------------|---------------------|-------------------------------------------------------------------|
| Single channel | CONFIG, addr 0x1A    | ACTIVE_CHAN [15:14] | 00 = chan 0<br>01 = chan 1<br>10 = chan 2<br>11 = chan 3          |
|                | MUX_CONFIG addr 0x1B | AUTOSCAN_EN [15]    | 0 = continuous conversion on a single channel (default)           |
| Multi-channel  | MUX_CONFIG addr 0x1B | AUTOSCAN_EN [15]    | 1 = continuous conversion on multiple channels                    |
|                | MUX_CONFIG addr 0x1B | RR_SEQUENCE [14:13] | 00 = Ch0, Ch 1<br>01 = Ch0, Ch 1, Ch 2<br>10 = Ch0, Ch1, Ch2, Ch3 |

(1) Channels 2 and 3 are only available for LDC1314

The digitized sensor measurement for each channel (DATA<sub>x</sub>) represents the ratio of the sensor frequency to the reference frequency. The data outputs represent the 12 MSBs of a 16-bit result. With the FIN\_DIVIDER set to 1 and OFFSET set to 0, the sensor frequency can be calculated from:

$$f_{\text{sensorx}} = \frac{\text{DATA}_x * f_{\text{REFx}}}{2^{12}} \quad (4)$$

The following table illustrates the registers that contain the fixed point sample values for each channel.

**Table 33. LDC1314/1312 Sample Data Registers**

| CHANNEL <sup>(1)</sup> | REGISTER         | FIELD NAME [BITS(S) ] | VALUE                                                                                                     |
|------------------------|------------------|-----------------------|-----------------------------------------------------------------------------------------------------------|
| 0                      | DATA0, addr 0x00 | DATA0 [11:0]          | 12 bit conversion results<br>0x000 = sensor under range condition<br>0xfff = sensor over range condition  |
| 1                      | DATA1, addr 0x02 | DATA1 [11:0]          | 12 bit conversion results.<br>0x000 = sensor under range condition<br>0xfff = sensor over range condition |
| 2                      | DATA2, addr 0x04 | DATA2 [11:0]          | 12 bit conversion result.<br>0x000 = sensor under range condition<br>0xfff = sensor over range condition  |

(1) Channels 2 and 3 available for LDC1314 only.

**Table 33. LDC1314/1312 Sample Data Registers (continued)**

| CHANNEL <sup>(1)</sup> | REGISTER         | FIELD NAME [BITS(S) ] | VALUE                                                                                                    |
|------------------------|------------------|-----------------------|----------------------------------------------------------------------------------------------------------|
| 3                      | DATA3, addr 0x06 | DATA3 [11:0]          | 12 bit conversion result.<br>0x000 = sensor under range condition<br>0xfff = sensor over range condition |

$$\text{DATA}_x = \text{DATA}_x\_MSB \times 65536 + \text{DATA}_x\_LSB \quad (5)$$

### 8.1.3.1 Data Offset

An offset value may be subtracted from each DATA value to compensate for a frequency offset or maximize the dynamic range of the sample data. The offset values should be  $< f_{\text{SENSOR}_x\_MIN} / f_{\text{REF}_x}$ . Otherwise, the offset might be so large that it masks the LSBs which are changing.

**Table 34. Frequency Offset Registers**

| CHANNEL <sup>(1)</sup> | REGISTER           | FIELD [ BIT(S) ] | VALUE                                                                 |
|------------------------|--------------------|------------------|-----------------------------------------------------------------------|
| 0                      | OFFSET0, addr 0x0C | OFFSET0 [ 15:0 ] | $f_{\text{OFFSET0}} = \text{OFFSET0} \times (f_{\text{REF0}}/2^{16})$ |
| 1                      | OFFSET1, addr 0x0D | OFFSET1 [ 15:0 ] | $f_{\text{OFFSET1}} = \text{OFFSET1} \times (f_{\text{REF1}}/2^{16})$ |
| 2                      | OFFSET2, addr 0x0E | OFFSET2 [ 15:0 ] | $f_{\text{OFFSET2}} = \text{OFFSET2} \times (f_{\text{REF2}}/2^{16})$ |
| 3                      | OFFSET3, addr 0x0F | OFFSET3 [ 15:0 ] | $f_{\text{OFFSET3}} = \text{OFFSET3} \times (f_{\text{REF3}}/2^{16})$ |

The sensor frequency can be determined by:

$$f_{\text{SENSOR}_x} = \text{CH}_x\_FIN\_DIVIDER * f_{\text{REF}_x} \left( \frac{\text{DATA}_x}{2^{(12+\text{OUTPUT\_GAIN})}} + \frac{\text{CH}_x\_OFFSET}{2^{16}} \right)$$

where:

- DATA<sub>x</sub> = Conversion result from the DATA<sub>x</sub> register
- OFFSET<sub>x</sub> = Offset value set in the OFFSET<sub>x</sub> register
- OUTPUT\_GAIN = output multiplication factor set in the RESET\_DEVICE.OUTPUT\_GAIN register

### 8.1.3.2 Digital Signal Gain

Internally, the LDC measures inductance shifts with 16 bits of resolution, while the conversion output word width is only 12 bits. For systems in which the sensor signal variation is less than 25% of the full scale range, the LDC can report conversion results with higher resolution by setting the Output Gain. The Output Gain is applied to all device channels. An output gain can be used to apply a 2-bit, 3-bit, or 4-bit shift to the output code for all channels, providing an effectively higher measurement resolution. When the Gain function is used, additional LSBs of the conversion word are reported, while the corresponding number of MSBs are not reported.

To avoid data corruption issues, use the Output Gain function ([Data Offset](#)) to shift the output codes to prevent toggling of the shifted MSBs.

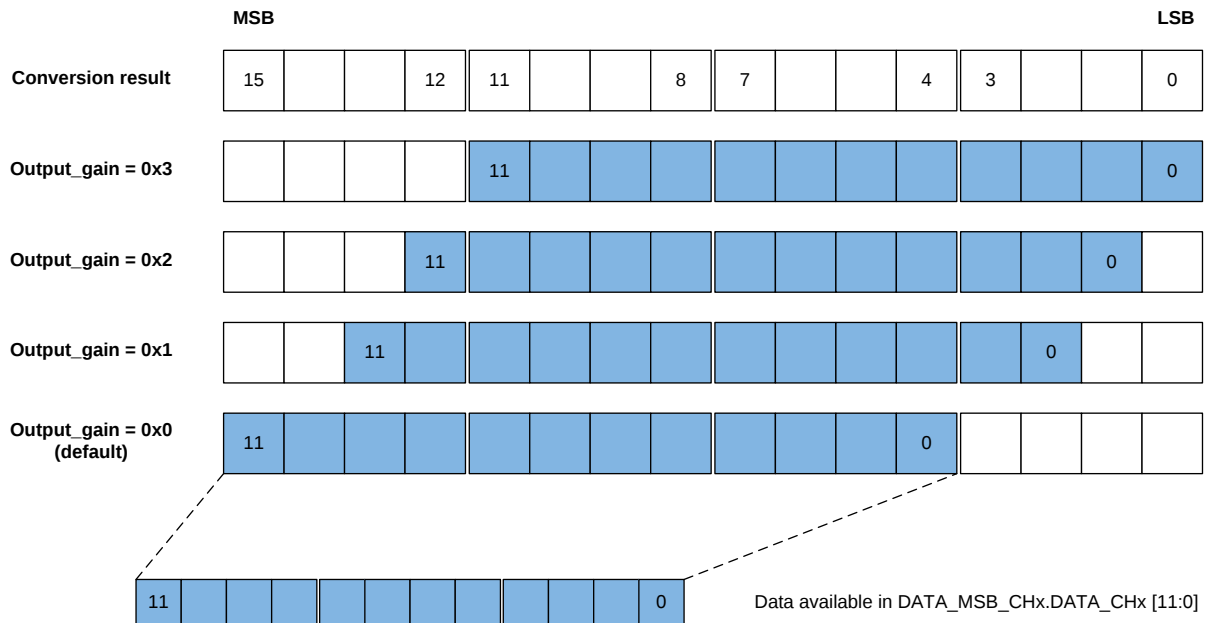
**Table 35. Output Gain Register**

| CHANNEL <sup>(1)</sup> | REGISTER             | FIELD [ BIT(S) ]     | VALUES                               | EFFECTIVE RESOLUTION (BITS) | OUTPUT RANGE     |
|------------------------|----------------------|----------------------|--------------------------------------|-----------------------------|------------------|
| All                    | RESET_DEV, addr 0x1C | OUTPUT_GAIN [ 10:9 ] | 00 (default): Gain =1 (0 bits shift) | 12                          | 100% full scale  |
|                        |                      |                      | 01: Gain = 4 (2 bits left shift)     | 14                          | 25% full scale   |
|                        |                      |                      | 10: Gain = 8 (3 bits left shift)     | 15                          | 12.5% full scale |
|                        |                      |                      | 11 : Gain = 16 (4 bits left shift)   | 16                          | 6.25% full scale |

(1) Channels 2 and 3 are only available for LDC1314

(1) Channels 2 and 3 are available for LDC1314 only.

**Example:** If the conversion result for a channel is 0x07A3, with OUTPUT\_GAIN=0x0, the reported output code is 0x07A. If OUTPUT\_GAIN is set to 0x3 in the same condition, then the reported output code is 0x7A3. The original 4 MSBs (0x0) are no longer accessible. Figure 51 illustrates the segments of the 16-bit sample that is reported for each possible gain setting.



**Figure 51. Conversion Data Output Gain**

#### 8.1.4 Sensor Conversion Time

The LDC1312/LDC1314 provides a configurable conversion time by setting an internal register. The conversion interval can be configured across a range of 1.2  $\mu$ s to >26.2 ms with 16 bits of resolution. Note that it is possible to configure the conversion interval to be significantly shorter than the time required to readback the DATAx registers; when configured in this manner, older conversions for a channel are overwritten when new conversion data is completed for each channel. The conversion interval is set in multiples of the reference clock period by setting the RCOUNTx register value. The conversion time for any channel x is:

$$t_{Cx} = (RCOUNTx \times 16 + 4) / f_{REFx} \quad (7)$$

In general, a longer conversion time will provide a higher resolution inductance measurement. The reference count value should be chosen to support both the required sample rate and the necessary resolution. Refer to the TI Application Note [Optimizing L Measurement Resolution for the LDC1312 and LDC1314](#) for more information.

**Table 36. Conversion Time Configuration Registers, Channels 0 - 3<sup>(1)</sup>**

| CHANNEL | REGISTER           | FIELD          | CONVERSION TIME                  |
|---------|--------------------|----------------|----------------------------------|
| 0       | RCOUNT0, addr 0x08 | RCOUNT0 [15:0] | $(RCOUNT0 \times 16) / f_{REF0}$ |
| 1       | RCOUNT1, addr 0x09 | RCOUNT1 [15:0] | $(RCOUNT1 \times 16) / f_{REF1}$ |
| 2       | RCOUNT2, addr 0x0A | RCOUNT2 [15:0] | $(RCOUNT2 \times 16) / f_{REF2}$ |
| 3       | RCOUNT3, addr 0x0B | RCOUNT3 [15:0] | $(RCOUNT3 \times 16) / f_{REF3}$ |

(1) Channels 2 and 3 are available only for LDC1314.

The typical channel switch delay time between the end of conversion and the beginning of sensor activation of the subsequent channel is:

$$\text{Channel Switch Delay} = 692 \text{ ns} + 5 / f_{ref} \quad (8)$$

The deterministic conversion time of the LDC allows data polling at a fixed interval. A data ready flag (DRDY) can assert the INTB pin for use in interrupt driven system designs (see the STATUS register description in [Register Maps](#)).

### 8.1.4.1 Settling Time

When the LDC sequences through the channels in multi-channel mode, the dwell time interval for each channel is the sum of 3 parts: sensor activation time + conversion time + channel switch delay.

The sensor activation time is the amount of settling time required for the sensor oscillation amplitude to stabilize, as shown in [Figure 49](#). The settling wait time is programmable and should be set to a value that is long enough to allow stable oscillation. The settling wait time for channel x is given by:

$$t_{sx} = (\text{SETTLECOUNTx} \times 16) / f_{\text{REFx}} \quad (9)$$

[Table 37](#) illustrates the registers and values for configuring the settling time for each channel.

**Table 37. Settling Time Register Configuration**

| CHANNEL <sup>(1)</sup> | REGISTER                | FIELD               | CONVERSION TIME <sup>(2)</sup>      |
|------------------------|-------------------------|---------------------|-------------------------------------|
| 0                      | SETTLECOUNT0, addr 0x10 | SETTLECOUNT0 [15:0] | (SETTLECOUNT0×16)/f <sub>REF0</sub> |
| 1                      | SETTLECOUNT1, addr 0x11 | SETTLECOUNT1 [15:0] | (SETTLECOUNT1×16)/f <sub>REF1</sub> |
| 2                      | SETTLECOUNT2, addr 0x12 | SETTLECOUNT2 [15:0] | (SETTLECOUNT2×16)/f <sub>REF2</sub> |
| 3                      | SETTLECOUNT3, addr 0x13 | SETTLECOUNT3 [15:0] | (SETTLECOUNT3×16)/f <sub>REF3</sub> |

(1) Channels 2 and 3 are available only in the LDC1314.

(2)  $f_{\text{REFx}}$  is the reference frequency configured for the channel.

The SETTLECOUNTx for any channel x must satisfy:

$$\text{SETTLECOUNTx} \geq Q_{\text{SENSORx}} \times f_{\text{REFx}} / (16 \times f_{\text{SENSORx}})$$

where:

- $f_{\text{SENSORx}}$  = Sensor Frequency of Channel x
- $f_{\text{REFx}}$  = Reference frequency for Channel x
- $Q_{\text{SENSORx}}$  = Quality factor of the sensor on Channel x. The sensor Q can be calculated with: (10)

$$Q = R_p \sqrt{\frac{C}{L}} \quad (11)$$

Round the result to the next highest integer (for example, if [Equation 10](#) recommends a minimum value of 6.08, program the register to 7 or higher).

L, R<sub>p</sub> and C values can be obtained by using Texas Instrument's [WEBENCH®](#) for the coil design.

### 8.1.4.2 Sensor Activation

The LDC1312/LDC1314 provides option to either reduce the sensor activation time or to reduce the device current consumption during the sensor activation time.

This can reduce the sensor activation time for higher-Q sensors by driving the maximum sensor drive current during the sensor settling time. The maximum sensor drive current is nominally 1.56 mA. Sensors already configured to use the maximum drive current setting (IDRIVEx = b11111) will see no change in operation based on this setting.

This mode is selected by setting SENSOR\_ACTIVATE\_SEL to 0.

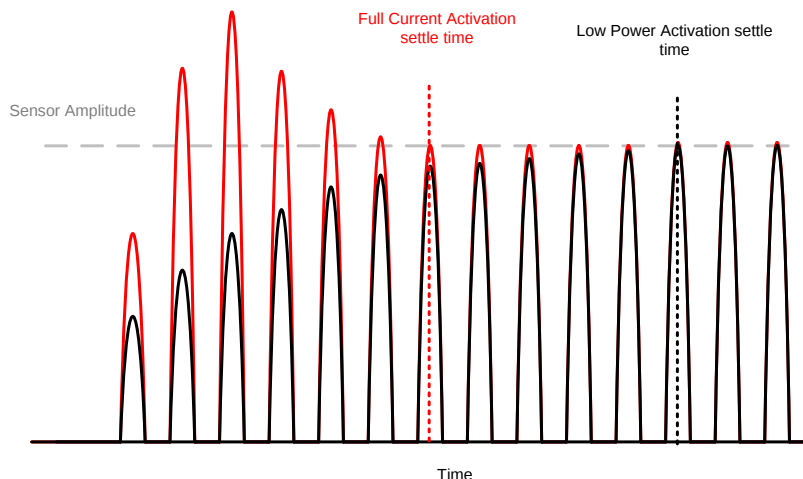


Figure 52. Sensor Full Current Activation vs. Low Power Activation

### 8.1.5 Sensor Current Drive Configuration

The registers listed in [Table 38](#) are used to control the sensor drive current so that the sensor signal amplitude is within the optimum range of  $1.2 V_P$  to  $1.8 V_P$  (sensor amplitudes outside this optimum range can be reported in the status register - refer to [Device Status Registers](#)). The device can still convert with sensor amplitudes lower than  $0.6 V_P$ , however the conversion noise will increase with lower sensor amplitudes. Below  $0.6 V_P$  the sensor oscillations may not be stable or may completely stop and the LDC will stop converting. If the current drive results in the oscillation amplitude greater than  $1.8 V$ , the internal ESD clamping circuit will become active. This may cause the sensor frequency to shift so that the output values no longer represent a valid system state. [Figure 53](#) shows the block diagram of the sensor driver. Each channel has an independent setting for the IDRIVE current used to set the sensor oscillation amplitude.

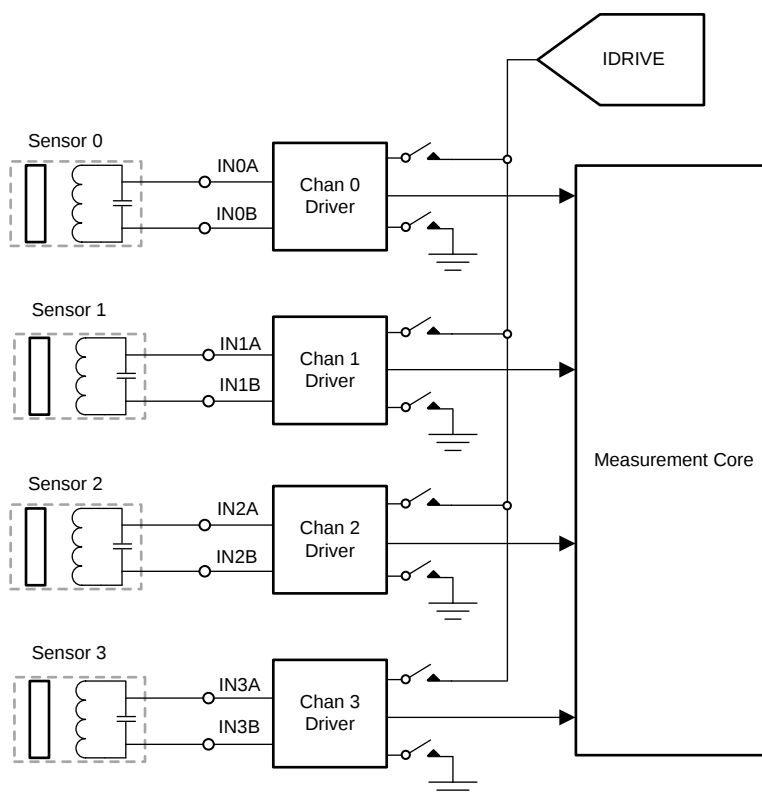


Figure 53. LDC1314 Sensor Driver Block Diagram

**Table 38. Current Drive Control Registers**

| CHANNEL <sup>(1)</sup> | REGISTER                  | FIELD [ BIT(S) ]         | VALUE                                                                                                                                                     |
|------------------------|---------------------------|--------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------|
| All                    | CONFIG, addr 0x1A         | SENSOR_ACTIVATE_SEL [11] | Sets current drive for sensor activation. Recommended value is b0 (Full Current mode).                                                                    |
|                        |                           | RP_OVERRIDE_EN [12]      | Set to b1 for normal operation (RP Override enabled)                                                                                                      |
|                        |                           | AUTO_AMP_DIS [10]        | Disables Automatic amplitude correction. Set to b1 for normal operation (disabled)                                                                        |
| 0                      | CONFIG, addr 0x1A         | HIGH_CURRENT_DRV [6]     | b0 = normal current drive (1.5 mA)<br>b1 = Increased current drive (> 1.5 mA) for Ch 0 in single channel mode only. Cannot be used in multi-channel mode. |
| 0                      | DRIVE_CURRENT0, addr 0x1E | IDRIVE0 [15:11]          | Drive current used during the settling and conversion time for Ch. 0 (auto-amplitude correction must be disabled and RP override=1 )                      |
|                        |                           | INIT_IDRIVE0 [10:6]      | Initial drive current stored during auto-calibration. Not used for normal operation.                                                                      |
| 1                      | DRIVE_CURRENT1, addr 0x1F | IDRIVE1 [15:11]          | Drive current used during the settling and conversion time for Ch. 1 (auto-amplitude correction must be disabled and RP override=1 )                      |
|                        |                           | INIT_IDRIVE1 [10:6]      | Initial drive current stored during auto-calibration. Not used for normal operation.                                                                      |
| 2                      | DRIVE_CURRENT2, addr 0x20 | IDRIVE2 [15:11]          | Drive current used during the settling and conversion time for Ch. 2 (auto-amplitude correction must be disabled and RP override=1 )                      |
|                        |                           | INIT_IDRIVE2 [10:6]      | Initial drive current stored during auto-calibration. Not used for normal operation.                                                                      |
| 3                      | DRIVE_CURRENT3, addr 0x21 | IDRIVE3 [15:11]          | Drive current used during the settling and conversion time for Ch. 3 (auto-amplitude correction must be disabled and RP override=1 )                      |
|                        |                           | INIT_IDRIVE3 [10:6]      | Initial drive current stored during auto-calibration. Not used for normal operation.                                                                      |

(1) Channels 2 and 3 are available for LDC1314 only.

If the  $R_P$  value of the sensor attached to Channel x is known, [Table 39](#) can be used to select the 5-bit value to be programmed into the IDRIVEx field for the channel. If the measured  $R_P$  (at maximum spacing between the sensor and the target) falls between two of the table values, use the current drive value associated with the lower  $R_P$  from the table. All channels that use an identical sensor/target configuration can use the same IDRIVEx value. The appropriate sensor drive current can be calculated with:

$$I_{DRIVE} = \pi V_P \div 4R_P \quad (12)$$

**Table 39. Optimum Sensor  $R_P$  Ranges for Sensor IDRIVEx Setting.**

| IDRIVEx Register Field Value | Nominal Sensor Current ( $\mu A$ ) | Minimum Sensor $R_P$ (k $\Omega$ ) | Maximum Sensor $R_P$ (k $\Omega$ ) |
|------------------------------|------------------------------------|------------------------------------|------------------------------------|
| 0                            | b00000                             | 16                                 | 60.0                               |
| 1                            | b00001                             | 18                                 | 51.8                               |
| 2                            | b00010                             | 20                                 | 44.6                               |
| 3                            | b00011                             | 23                                 | 38.4                               |
| 4                            | b00100                             | 28                                 | 33.7                               |
| 5                            | b00101                             | 32                                 | 29.5                               |
| 6                            | b00110                             | 40                                 | 23.6                               |
| 7                            | b00111                             | 46                                 | 20.5                               |
| 8                            | b01000                             | 52                                 | 18.1                               |

**Table 39. Optimum Sensor  $R_p$  Ranges for Sensor IDRIVEx Setting. (continued)**

| IDRIVEx Register Field Value |        | Nominal Sensor Current ( $\mu$ A) | Minimum Sensor $R_p$ (k $\Omega$ ) | Maximum Sensor $R_p$ (k $\Omega$ ) |
|------------------------------|--------|-----------------------------------|------------------------------------|------------------------------------|
| 9                            | b01001 | 59                                | 16.1                               | 23.6                               |
| 10                           | b01010 | 72                                | 13.1                               | 20.4                               |
| 11                           | b01011 | 82                                | 11.5                               | 17.6                               |
| 12                           | b01100 | 95                                | 9.92                               | 15.1                               |
| 13                           | b01101 | 110                               | 8.57                               | 13.0                               |
| 14                           | b01110 | 127                               | 7.42                               | 11.2                               |
| 15                           | b01111 | 146                               | 6.46                               | 9.69                               |
| 16                           | b10000 | 169                               | 5.58                               | 8.35                               |
| 17                           | b10001 | 195                               | 4.83                               | 7.20                               |
| 18                           | b10010 | 212                               | 4.45                               | 6.21                               |
| 19                           | b10011 | 244                               | 3.86                               | 5.35                               |
| 20                           | b10100 | 297                               | 3.17                               | 4.61                               |
| 21                           | b10101 | 342                               | 2.76                               | 3.97                               |
| 22                           | b10110 | 424                               | 2.22                               | 3.42                               |
| 23                           | b10111 | 489                               | 1.93                               | 2.95                               |
| 24                           | b11000 | 551                               | 1.71                               | 2.54                               |
| 25                           | b11001 | 635                               | 1.48                               | 2.19                               |
| 26                           | b11010 | 763                               | 1.24                               | 1.89                               |
| 27                           | b11011 | 880                               | 1.07                               | 1.63                               |
| 28                           | b11100 | 1017                              | 0.93                               | 1.40                               |
| 29                           | b11101 | 1173                              | 0.80                               | 1.21                               |
| 30                           | b11110 | 1355                              | 0.70                               | 1.05                               |
| 31                           | b11111 | 1563                              | 0.60                               | 0.90                               |

Sensors with  $R_p$  greater than 90 k $\Omega$  can be driven by placing a 100 k $\Omega$  resistor in parallel with the sensor inductor to reduce the effective  $R_p$ .

Sensors which have a wide range of  $R_p$  may require more than one current drive setting across the range of operation - the current would need to be dynamically set based on the target position. Note that some high-resolution applications will experience an output code offset when the current drive is changed. Another approach for systems which have a wide range of  $R_p$  is to place a discrete resistor in parallel with the inductor to limit the range of  $R_p$  variation in the system. This will also reduce the sensor  $Q$ , and so may not be feasible for some implementations.

#### 8.1.5.1 Inactive Channel Sensor Connections

The LDC1312/LDC1314 ties the INAx and INBx pins for all channels to ground by ~10  $\Omega$  except for the active channel; in Sleep and Shutdown modes there are no active channels and so all channels are tied to ground. By grounding the channels, potential interactions between sensors are minimized. For multi-channel sequencing, only the active channel is driven with the IDRIVE current during the conversion time; once the conversion for the specific channel completes, the sensor is tied to ground to shut off the sensor, and the next sensor is activated.

For systems which do not use all sensor channels, it is acceptable to leave the unused INAx and INBx pins No-Connect.

### 8.1.5.2 Automatic IDRIVE Setting with RP\_OVERRIDE\_EN

The LDC1312/LDC1314 can automatically determine the appropriate sensor current drive when entering Active Mode. For the majority of applications, it is recommended to program a fixed current drive for consistent measurement performance. The automatic sensor amplitude setting is useful for initial system prototyping if the sensor amplitude is unknown. When this function is enabled, the LDC attempts to find the IDRIVEx setting which results in a sensor amplitude between  $1.2 V_P$  and  $1.8 V_P$ . For systems which have a large variation in target interaction, the LDC1312/LDC1314 may select a current drive setting which has poorer repeatability over the range of target interactions. In addition, measurement repeatability will be poorer with different sensor current drives. To enable the automatic sensor amplitude, set RP\_OVERRIDE to b0.

The following sequence uses auto-calibration to configure sensor drive current for a sensor with an unknown  $R_P$ :

1. Set target at the maximum planned operating distance from the sensor.
2. Place the device into SLEEP mode by setting CONFIG.SLEEP\_MODE\_EN to b0.
3. Program the desired values of SETTLECOUNT and RCOUNT values for the channel.
4. Enable auto-calibration by setting RP\_OVERRIDE\_EN to b0.
5. Take the device out of SLEEP mode by setting CONFIG.SLEEP\_MODE\_EN to b1.
6. Allow the device to perform at least one measurement, with the target stable (fixed) at the maximum operating range.
7. Read the channel current drive value from the appropriate DRIVE\_CURRENTx register (addresses 0x1e, 0x1f, 0x20, or 0x21), in the INIT\_DRIVEx field (bits 10:6). Save this value.
8. During startup for normal operating mode, write the value saved from the INIT\_DRIVEx bit field into the IDRIVEx bit field (bits 15:11).
9. During normal operating mode, the RP\_OVERRIDE\_EN should be set to b1 for a fixed current drive.

If the current drive results in the oscillation amplitude greater than 1.8 V, the internal ESD clamping circuit will become active. This may cause the sensor frequency to shift so that the output values no longer represent a valid system state. If the current drive is set at a lower value, the SNR performance of the system will decrease, and at near zero target range, oscillations may completely stop, and the output sample values will be all zeroes.

If there are significant differences in the sensor construction for different channels, then this process should be repeated for each channel.

### 8.1.5.3 Determining Sensor IDRIVE for an Unknown Sensor $R_P$ Using an Oscilloscope

If the sensor  $R_P$  is not known, probing the sensor amplitude with an oscilloscope can be used set IDRIVEx.

An iterative process of adjusting the drive current setting while monitoring the signal amplitude on INAx or INBx to ground is sufficient. Simply move the sensor target to the farthest planned operating distance from the sensor, and measure the channel amplitude after the amplitude has stabilized. If the sensor amplitude is less than  $1.5 V_P$ , increase the channel IDRIVE setting. If the sensor amplitude settles to greater than  $1.75 V_P$ , decrease the channel IDRIVE setting. If there are significant differences in the sensor construction for different channels, then this process should be repeated for each channel.

### 8.1.5.4 Sensor Auto-Calibration Mode

The LDC includes a sensor current Auto-calibration mode which can be dynamically set the sensor drive current. The auto-amplitude correction attempts to maintain the sensor oscillation amplitude between 1.2V and 1.8V by adjusting the sensor drive current between conversions.

This functionality is enabled by setting AUTO\_AMP\_DIS to b0, and applies to all active channels. The INIT\_IDRIVEx register field will be updated with the current drive value as the sensor current drive setting changes. The value of the INIT\_IDRIVEx register field matches the setting of the IDRIVEx register field. For example, an INIT\_IDRIVEx field with b10001 corresponds to a current drive of 195  $\mu A$ .

When auto-amplitude correction is active, the output data may experience offsets in the channel output code due to adjustments in drive current. Due to these offsets, Auto-amplitude correction is generally not recommended for use in high precision applications.

### 8.1.5.5 Channel 0 High Current Drive

Channel 0 provides a high sensor current drive mode to drive sensor coils with a typical drive current >3.5 mA. This feature can be used to drive sensors with an  $R_p$  lower than 350  $\Omega$ . Set the HIGH\_CURRENT\_DRV field to b1 to enable this mode. This drive mode is only available on Channel 0, and can only be enabled in single channel mode (AUTOSCAN\_EN = 0).

### 8.1.6 Clocking Architecture

Optimum LDC1312/LDC1314 performance requires a clean reference clock with a limited frequency range. The device provides digital dividers for the  $f_{CLK}$  and the sensor inputs. The dividers provide flexibility in system design, so that the full range of sensor frequencies can be supported with available  $f_{CLK}$ . Each channel has a dedicated divider configuration. Higher reference frequencies provide a higher sample rate for a given resolution.

Figure 54 shows the clock dividers and multiplexers of the LDC.

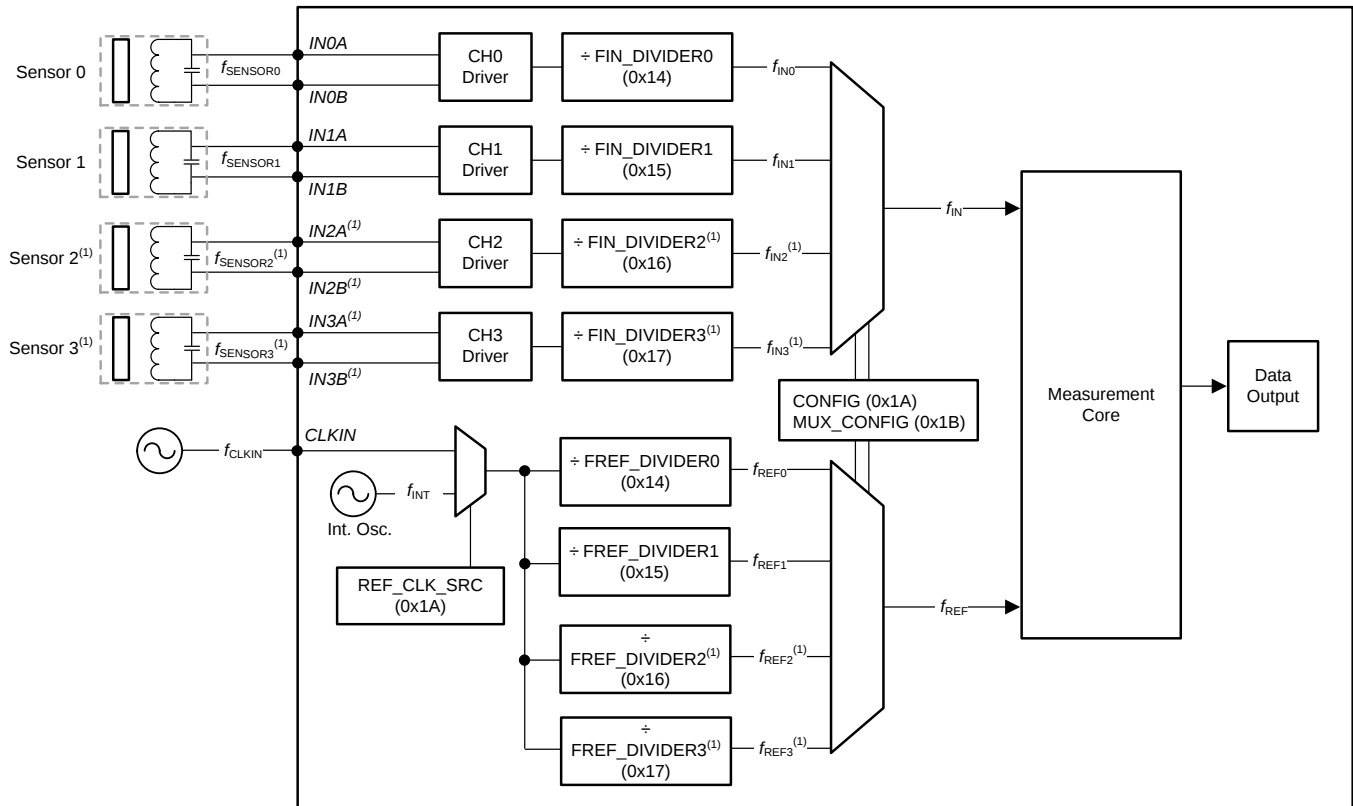


Figure 54. Clocking Diagram

(1) LDC1314 only

In Figure 54, the key clocks are  $f_{INx}$ ,  $f_{REFx}$ , and  $f_{CLK}$ .  $f_{CLK}$  is selected from either the internal clock source or external clock source (CLKIN). The frequency measurement reference clock,  $f_{REF}$ , is derived from the  $f_{CLK}$  source.

The internal oscillator is highly stable across temperature and is suitable for most LDC1312/4 applications. Applications requiring matched performance across multiple LDC1312/4 devices and/or requiring higher long-term stability may need an external oscillator. Note that some internal functions, such as watchdog timers, always use  $f_{INT}$  for timing.

The  $f_{INx}$  clock is derived from sensor frequency for channel x,  $f_{SENSORx}$ .  $f_{REFx}$  and  $f_{INx}$  must meet the requirements listed in Table 40, depending on whether  $f_{CLK}$  (reference clock) is the internal or external clock.

**Table 40. Clock Frequency Requirements**

| MODE <sup>(1)</sup> | REFERENCE SOURCE            | VALID $f_{REFx}$ RANGE | VALID $f_{INx}$ RANGE | SET FIN_DIVIDERx to         | VALID SETTLECOUNTx SETTINGS | VALID RCOUNTx SETTINGS |
|---------------------|-----------------------------|------------------------|-----------------------|-----------------------------|-----------------------------|------------------------|
| Multi-Channel       | Internal                    | $f_{REFx} \leq 55$ MHz | $< f_{REFx} / 4$      | $\geq b0001$ <sup>(2)</sup> | $> 3$                       | $> 8$                  |
|                     | External                    | $f_{REFx} \leq 40$ MHz |                       |                             |                             |                        |
| Single-Channel      | Either external or internal | $f_{REFx} \leq 35$ MHz |                       |                             |                             |                        |

(1) Channels 2 and 3 are only available for LDC1314

(2) If  $f_{SENSOR} \geq 8.75$  MHz, then FIN\_DIVIDERx must be  $\geq 2$

Table 41 shows the clock configuration registers. Each input channel has a dedicated configuration which can be set independently.

**Table 41. Clock Configuration Registers**

| CHANNEL <sup>(1)</sup> | CLOCK                              | REGISTER                   | FIELD                | VALUE                                                                                                                |
|------------------------|------------------------------------|----------------------------|----------------------|----------------------------------------------------------------------------------------------------------------------|
| All                    | $f_{CLK}$ = Reference Clock Source | CONFIG, addr 0x1A          | REF_CLK_SRC [9]      | b0 = internal oscillator is used as the reference clock<br>b1 = external clock source is used as the reference clock |
| 0                      | $f_{REF0}$                         | CLOCK_DIVIDERS0, addr 0x14 | FREF_DIVIDER0 [9:0]  | $f_{REF0} = f_{CLK} / FREF\_DIVIDER0$                                                                                |
| 1                      | $f_{REF1}$                         | CLOCK_DIVIDERS1, addr 0x15 | FREF_DIVIDER1 [9:0]  | $f_{REF1} = f_{CLK} / FREF\_DIVIDER1$                                                                                |
| 2                      | $f_{REF2}$                         | CLOCK_DIVIDERS2, addr 0x16 | FREF_DIVIDER2 [9:0]  | $f_{REF2} = f_{CLK} / FREF\_DIVIDER2$                                                                                |
| 3                      | $f_{REF3}$                         | CLOCK_DIVIDERS3, addr 0x17 | FREF_DIVIDER3 [9:0]  | $f_{REF3} = f_{CLK} / FREF\_DIVIDER3$                                                                                |
| 0                      | $f_{IN0}$                          | CLOCK_DIVIDERS0, addr 0x14 | FIN_DIVIDER0 [15:12] | $f_{IN0} = f_{SENSOR0} / FIN\_DIVIDER0$                                                                              |
| 1                      | $f_{IN1}$                          | CLOCK_DIVIDERS1, addr 0x15 | FIN_DIVIDER1 [15:12] | $f_{IN1} = f_{SENSOR1} / FIN\_DIVIDER1$                                                                              |
| 2                      | $f_{IN2}$                          | CLOCK_DIVIDERS2, addr 0x16 | FIN_DIVIDER2 [15:12] | $f_{IN2} = f_{SENSOR2} / FIN\_DIVIDER2$                                                                              |
| 3                      | $f_{IN3}$                          | CLOCK_DIVIDERS3, addr 0x17 | FIN_DIVIDER3 [15:12] | $f_{IN3} = f_{SENSOR3} / FIN\_DIVIDER3$                                                                              |

(1) Channels 2 and 3 are only available for LDC1314

### 8.1.7 Input Deglitch Filter

The input deglitch filter suppresses EMI and ringing above the sensor frequency. It does not impact the conversion result as long as its bandwidth is configured to be above the maximum sensor frequency. The input deglitch filter can be configured in MUX\_CONFIG.DEGLITCH register field as shown in Table 42. This setting applies to all channels. For optimal performance, it is recommended to select the lowest setting that exceeds the highest sensor oscillation frequency for all selected channels. For example, if the maximum sensor frequency is 2.8 MHz, choose MUX\_CONFIG.DEGLITCH = b100 (3.3 MHz).

**Table 42. Input Deglitch Filter Register**

| CHANNEL <sup>(1)</sup> | MUX_CONFIG.DEGLITCH REGISTER VALUE | DEGLITCH FREQUENCY |
|------------------------|------------------------------------|--------------------|
| ALL                    | b001                               | 1.0 MHz            |
| ALL                    | b100                               | 3.3 MHz            |
| ALL                    | b101                               | 10 MHz             |
| ALL                    | b011                               | 33 MHz             |

(1) Channels 2 and 3 are available for LDC1314 only.

### 8.1.8 Device Status Registers

The LDC1312/LDC1314 can monitor and report on conversion results and the status of attached sensors using the registers listed in [Table 43](#).

**Table 43. Status Registers**

| CHANNEL <sup>(1)</sup> | REGISTER                | FIELDS [ BIT(S) ]                                                           | VALUES                                                                                       |
|------------------------|-------------------------|-----------------------------------------------------------------------------|----------------------------------------------------------------------------------------------|
| All                    | STATUS, addr 0x18       | 12 fields are available that contain various status bits [ 15:0 ]           | Refer to Register Maps section for a description of the individual status bits.              |
| All                    | ERROR_CONFIG, addr 0x19 | 12 fields are available that are used to configure error reporting [ 15:0 ] | Refer to Register Maps section for a description of the individual error configuration bits. |

(1) Channels 2 and 3 are available for LDC1314 only.

See the STATUS ([Table 21](#)) and ERROR\_CONFIG ([Table 22](#)) register descriptions in the Register Map section. These registers can be configured to trigger an interrupt on the INTB pin for certain events. The following conditions must be met:

1. The error or status register must be unmasked by enabling the appropriate register bit in the ERROR\_CONFIG register.
2. The INTB function must be enabled by setting CONFIG.INTB\_DIS to 0.

When a bit field in the STATUS register is set, the entire STATUS register content is held until read or until the DATAx register is read. Reading also de-asserts INTB. After first starting conversions in active mode, the first read of STATUS should be performed after assertion of INTB.

Interrupts are cleared by one of the following events:

1. Entering Sleep Mode
2. Power-on reset (POR)
3. Device enters Shutdown Mode (SD is asserted)
4. S/W reset
5. I2C read of the STATUS register: Reading the STATUS register will clear any error status bit set in STATUS along with the ERR\_CHAN field and de-assert INTB

Setting register CONFIG.INTB\_DIS to b1 disables the INTB function and holds the INTB pin high.

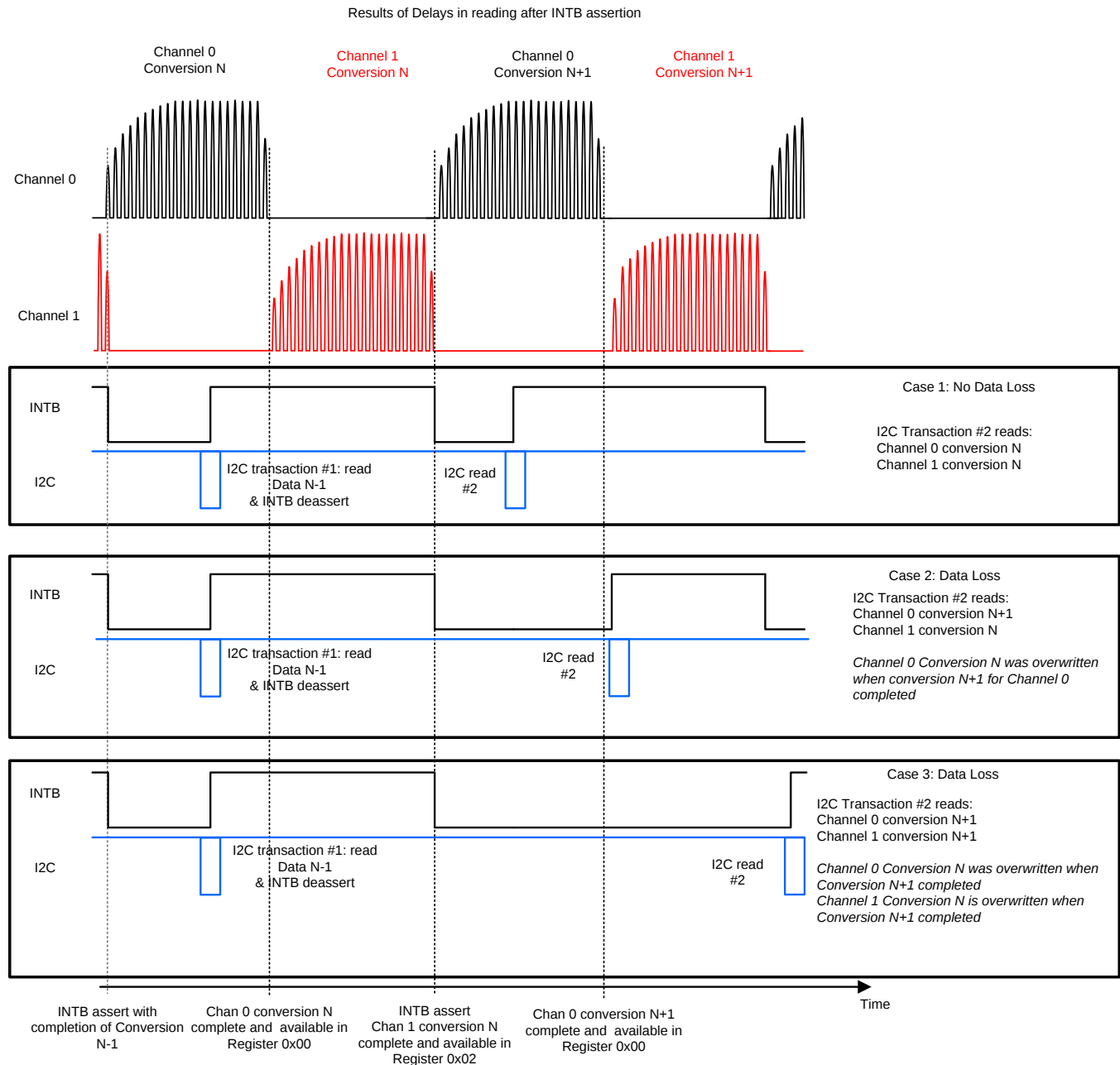
The TI Application Note [LDC1312, LDC1314, LDC1612, LDC1614 Sensor Status Monitoring](#) provides detailed information on sensor status reporting.

### 8.1.9 Multi-Channel Data Readback

When in multi-channel mode, the LDC1312/LDC1314 alternates conversions on all selected channels. After each channel conversion completes, the conversion results for that channel overwrites the previous conversion results with the new data.

When the device completes a conversion on the last channel in the selected group, the device will pull INTB low if DRDY2INT is set to 1. At this time, the conversion results should be retrieved via the I2C bus.

If the device is put into Sleep mode or Shutdown mode, all DATAx registers are cleared of conversion data.



**Figure 55. Data Readback Timing**

The STATUS register (Address 0x18) flags UNREADCONVx monitor the accesses to the DATAx registers.

When the DATAx register is read, the corresponding UNREADCONVx flag is cleared.

As shown in [Figure 55](#), if the I2C data readback is delayed, then it is possible to lose older, unread conversion results. Monitoring the UNREADCONVx flags are useful to assess whether data loss is occurring.

A delayed read of previous conversion results can produce the condition in which reading the STATUS register immediately after INTB asserts shows that Channel 0 has no unread data (where the UNREADCONV0 flag is 0), but other channels do have unread data indicated by the corresponding UNREADCONVx flags.

## 8.2 Typical Application

### 8.2.1 System Sensing Functionality

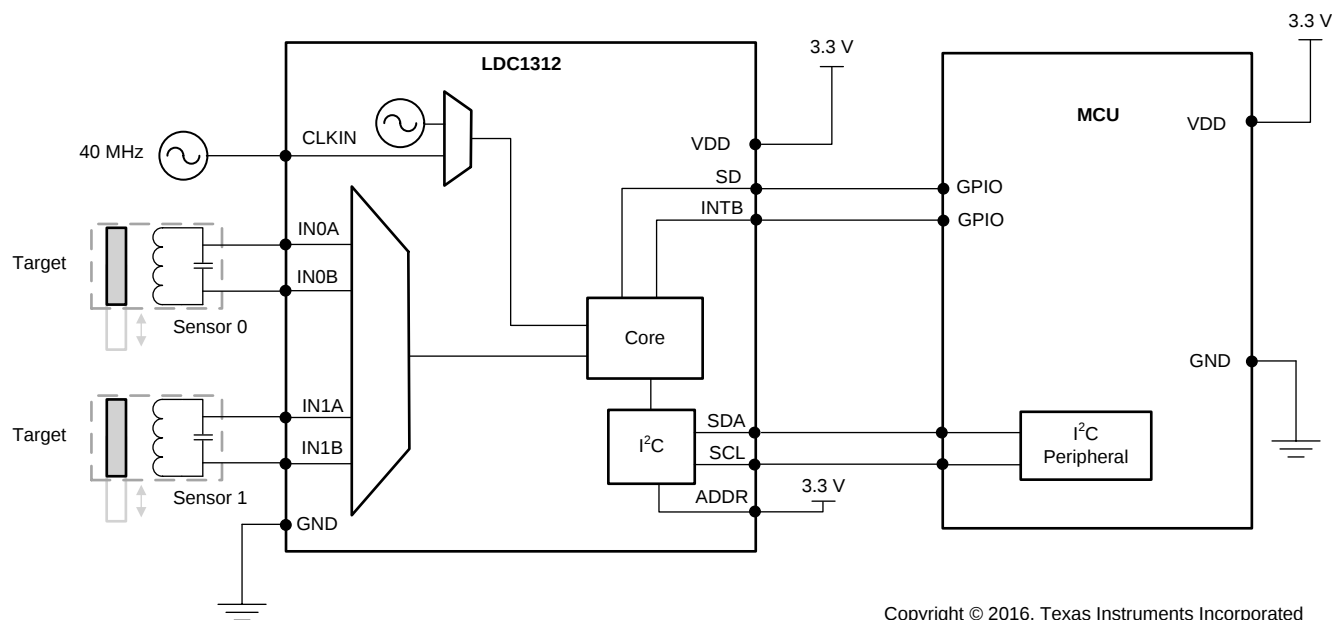
Inductive sensing provides a wide range of system advantages that no other technology can provide - contactless measurement, resistance to dirt/dust/water, immunity to external magnets, remote sensor positioning, inexpensive and robust sensors, and high resolution measurement of relative movement.

The LDC1312/LDC1314 can be used to sense a wide range of applications for measuring a variety of target movement:

- Angular Measurement: refer to [1-Degree Dial Reference Design](#) for an example implementation.
- Linear Position Sensing: details on sensor and target construction are available in [LDC1612/LDC1614 Linear Position Sensing Application Note](#). For absolute positioning needs, it is recommended to use a differential 2 channel construction.
- Encoder Knob: refer to [Inductive Sensing 32-Position Encoder Knob Reference Design](#) for an example system implementation.
- Inductive buttons using snap-domes: refer to [16-Button Inductive Keypad Reference Design](#) for an example system implementation.

### 8.2.2 Example Application

Example of a multi-channel implementation using the LDC1312. This example is representative of an axial displacement application, in which the target movement is perpendicular to the plane of the coil. The second channel can be used to sense proximity of a second target, or it can be used for environmental compensation by connecting a reference coil.



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**Figure 56. Example Multi-Channel Application - LDC1312**

### 8.2.3 Design Requirements

Design example in which Sensor 0 is used for proximity measurement and Sensor 1 is used for temperature compensation. WEBENCH coil designer tool used to create sensor. System measurement requirements:

- Target distance = 1.0 mm
- Distance resolution = 0.2  $\mu$ m
- Target diameter = 10 mm
- Target material = stainless steel (SS416)
- Number of PCB layers for the coil = 2
- The application requires 1 kSPS (  $T_{SAMPLE} = 1.00$  ms)

## Typical Application (continued)

### 8.2.4 Detailed Design Procedure

The target distance, resolution and diameter are used as inputs to WEBENCH to design the sensor coil. The resulting coil design is a 2 layer coil, with an area of 2.5 cm<sup>2</sup>, diameter of 17.7 mm, and 39 turns. The values for R<sub>p</sub>, L and C are: R<sub>p</sub> = 6.6 kΩ, L = 43.9 μH, C = 100 pF.

Using the L and C to determine  $f_{\text{SENSOR}} = 1/2\pi\sqrt{LC} = 1/2\pi\sqrt{43.9 \times 10^{-6} \times 100 \times 10^{-12}} = 2.4 \text{ MHz}$

With a system reference clock of 40 MHz applied to the CLKIN pin allows flexibility for setting the internal clock frequencies. The sensor coil is connected to channel 0 (IN0A and IN0B pins).

After powering on the LDC, it will be in Sleep Mode. Program the registers as follows (this example sets registers for channel 0 only; channel 1 registers can use equivalent configuration):

1. Set the dividers for Channel 0.
  - a. Because the sensor frequency is less than 8.75 MHz, the sensor divider can be set to 1, which means setting field FIN\_DIVIDER0 to 0x1. By default,  $f_{\text{IN0}} = f_{\text{SENSOR}} = 2.4 \text{ MHz}$ .
  - b. The design constraint for  $f_{\text{REF0}}$  is  $> 4 \times f_{\text{SENSOR}}$ . The 40 MHz reference frequency satisfies this constraint, so the reference divider can be set to 1. This is done by setting the FREF\_DIVIDER0 field to 0x01.
  - c. The combined value for Chan. 0 divider register (0x14) is 0x1002.
2. Program the settling time for Channel 0. The calculated Q of the coil is 10 (see [Multi-Channel and Single Channel Operation](#)).
  - a.  $\text{SETTLECOUNT0} \geq Q \times f_{\text{REF0}} / (16 \times f_{\text{SENSOR0}}) \rightarrow 5.2$ , rounded up to 6. To provide margin to account for system tolerances, a higher value of 10 is chosen.
  - b. Register 0x10 should be programmed to a minimum of 10.
  - c. The settle time is:  $(10 \times 16)/20,000,000 = 8 \mu\text{s}$
  - d. The value for SETTLECOUNT0 register (0x10) is 0x000A.
3. The channel switching delay is ~1 μs for  $f_{\text{REF}} = 20 \text{ MHz}$  (see [Multi-Channel and Single Channel Operation](#))
4. Set the conversion time by the programming the reference count for Channel 0. The budget for the conversion time is:  $T_{\text{SAMPLE}} - \text{settling time} - \text{channel switching delay} = 1000 - 8 - 1 = 991 \mu\text{s}$ 
  - a. To determine the conversion time register value, use the following equation and solve for RCOUNT0:  
Conversion Time ( $t_{\text{CO}}$ ) =  $(\text{RCOUNT0} \times 16)/f_{\text{REF0}}$ .
  - b. This results in RCOUNT0 having a value of 1238 decimal (rounded down)
  - c. Set the RCOUNT0 register (0x08) to 0x04D6.
5. Use the default values for the ERROR\_CONFIG register (address 0x19). By default, no interrupts are enabled
6. Sensor drive current: to set the IDRIVE0 field value, read the value from [Figure 52](#) using R<sub>p</sub> = 6.6 kΩ. In this case IDRIVE0 value should be set to 18 (decimal). The INIT\_DRIVE0 current field should be set to 0x00. The combined value for the DRIVE\_CURRENT0 register (addr 0x1E) is 0x9000.
7. Program the MUX\_CONFIG register
  - a. Set the AUTOSCAN\_EN to b1 bit to enable sequential mode
  - b. Set RR\_SEQUENCE to b00 to enable data conversion on two channels (channel 0, channel 1)
  - c. Set DEGLITCH to b100 to set the input deglitch filter bandwidth to 3.3MHz, the lowest setting that exceeds the oscillation tank frequency.
  - d. The combined value for the MUX\_CONFIG register (address 0x1B) is 0x820C
8. Finally, program the CONFIG register as follows:
  - a. Set the ACTIVE\_CHAN field to b00 to select channel 0.
  - b. Set SLEEP\_MODE\_EN field to b0 to enable conversion.
  - c. Set RP\_OVERRIDE\_EN to b1 to disable auto-calibration.
  - d. Set SENSOR\_ACTIVATE\_SEL = b0, for full current drive during sensor activation
  - e. Set the AUTO\_AMP\_DIS field to b1 to disable auto-amplitude correction
  - f. Set the REF\_CLK\_SRC field to b1 to use the external clock source.
  - g. Set the other fields to their default values.

## Typical Application (continued)

h. The combined value for the CONFIG register (address 0x1A) is 0x1601.

We then read the conversion results for channel 0 and channel 1 every 1.00 ms from register addresses 0x00 and 0x02.

### 8.2.5 Recommended Initial Register Configuration Values

Based on the example configuration in section [Detailed Design Procedure](#), the following register write sequence is recommended:

**Table 44. Recommended Initial Register Configuration Values (Single-Channel Operation)**

| ADDRESS | VALUE  | REGISTER NAME   | COMMENTS                                                                                                                                                                                                                                                                                                                       |
|---------|--------|-----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0x08    | 0x04D6 | RCOUNT0         | Reference count calculated from timing requirements (1 kSPS) and resolution requirements                                                                                                                                                                                                                                       |
| 0x10    | 0x000A | SETTLECOUNT0    | Minimum settling time for chosen sensor                                                                                                                                                                                                                                                                                        |
| 0x14    | 0x1002 | CLOCK_DIVIDERS0 | FIN_DIVIDER0 = 1, FREF_DIVIDER0 = 2                                                                                                                                                                                                                                                                                            |
| 0x19    | 0x0000 | ERROR_CONFIG    | Can be changed from default to report status and error conditions                                                                                                                                                                                                                                                              |
| 0x1B    | 0x020C | MUX_CONFIG      | Enable Channel 0 in continuous mode, set Input deglitch bandwidth to 3.3MHz                                                                                                                                                                                                                                                    |
| 0x1E    | 0x9000 | DRIVE_CURRENT0  | Sets sensor drive current on channel 0                                                                                                                                                                                                                                                                                         |
| 0x1A    | 0x1601 | CONFIG          | Select active channel = ch 0, disable auto-amplitude correction and auto-calibration, enable full current drive during sensor activation, select external clock source, wake up device to start conversion. This register write must occur last because device configuration is not permitted while the LDC is in active mode. |

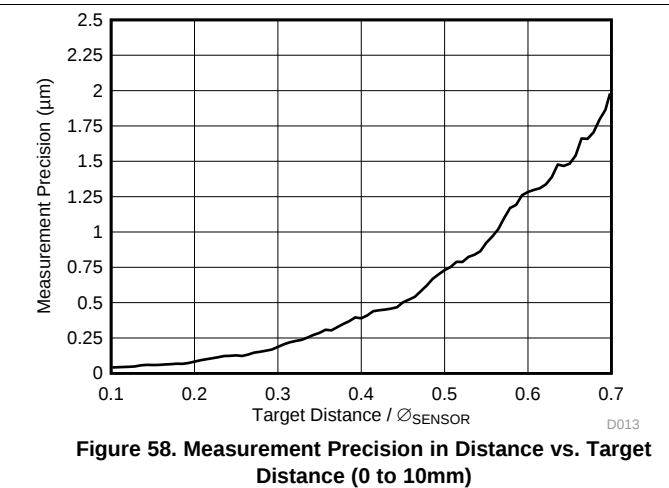
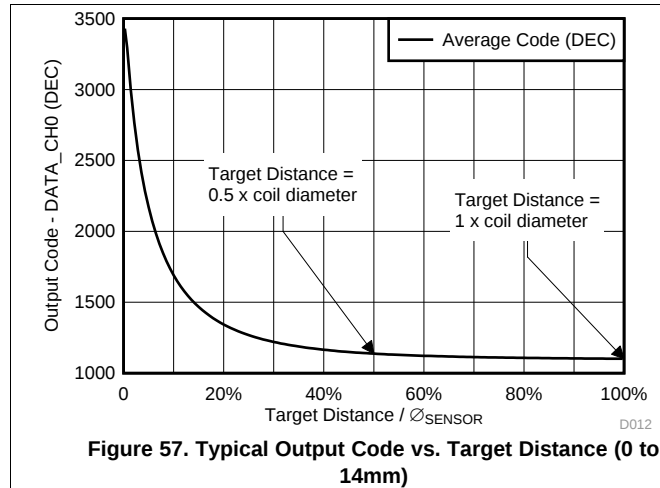
**Table 45. Recommended Initial Register Configuration Values (Multi-Channel Operation)**

| ADDRESS | VALUE  | REGISTER NAME    | COMMENTS                                                                                                                                                                                                                                                                                         |
|---------|--------|------------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 0x08    | 0x04D6 | RCOUNT0          | Reference count calculated from timing requirements (1 kSPS) and resolution requirements                                                                                                                                                                                                         |
| 0x09    | 0x04D6 | RCOUNT1          | Reference count calculated from timing requirements (1 kSPS) and resolution requirements                                                                                                                                                                                                         |
| 0x10    | 0x000A | SETTLECOUNT0     | Minimum settling time for chosen sensor                                                                                                                                                                                                                                                          |
| 0x11    | 0x000A | SETTLECOUNT1     | Minimum settling time for chosen sensor                                                                                                                                                                                                                                                          |
| 0x14    | 0x1002 | CLOCK_DIVIDERS0  | FIN_DIVIDER0 = 1, FREF_DIVIDER0 = 2                                                                                                                                                                                                                                                              |
| 0x15    | 0x1002 | CLOCK_DIVIDERS_1 | FIN_DIVIDER1 = 1, FREF_DIVIDER1 = 2                                                                                                                                                                                                                                                              |
| 0x19    | 0x0000 | ERROR_CONFIG     | Can be changed from default to report status and error conditions                                                                                                                                                                                                                                |
| 0x1B    | 0x820C | MUX_CONFIG       | Enable Ch 0 and Ch 1 (sequential mode), set Input deglitch bandwidth to 3.3MHz                                                                                                                                                                                                                   |
| 0x1E    | 0x9000 | DRIVE_CURRENT0   | Sets sensor drive current on ch 0                                                                                                                                                                                                                                                                |
| 0x1F    | 0x9000 | DRIVE_CURRENT1   | Sets sensor drive current on ch 1                                                                                                                                                                                                                                                                |
| 0x1A    | 0x1601 | CONFIG           | Disable auto-amplitude correction and auto-calibration, enable full current drive during sensor activation, select external clock source, wake up device to start conversion. This register write must occur last because device configuration is not permitted while the LDC is in active mode. |

## 8.2.6 Application Curves

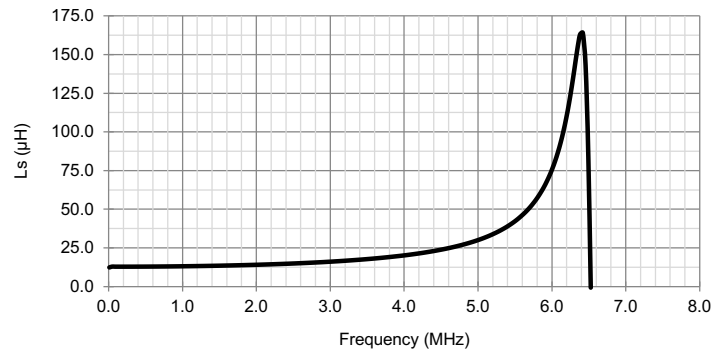
### Common Test Conditions (unless specified otherwise):

- Sensor inductor: 2 layer, 32 turns/layer, 14mm diameter, PCB inductor with  $L=19.4\ \mu\text{H}$ ,  $R_p=5.7\ \text{k}\Omega$  at 2 MHz
- Sensor capacitor: 330 pF 1% COG/NP0
- Target: Aluminum, 1.5 mm thickness
- Channel = Channel 0 (continuous mode)
- $f_{\text{CLKIN}} = 40\ \text{MHz}$ ,  $\text{FIN\_DIVIDERx} = 0x01$ ,  $\text{FREF\_DIVIDERx} = 0x001$
- $\text{RCOUNT0} = 0xFFFF$ ,  $\text{SETTLECOUNT0} = 0x0100$
- $\text{RP\_OVERRIDE} = 1$ ,  $\text{AUTO\_AMP\_DIS} = 1$ ,  $\text{DRIVE\_CURRENT0} = 0x9800$



### 8.2.7 Inductor Self-Resonant Frequency

Every inductor has a distributed parasitic capacitance, which is dependent on construction and geometry. At the Self-Resonant Frequency (SRF), the reactance of the inductor cancels the reactance of the parasitic capacitance. Above the SRF, the inductor will electrically appear to be a capacitor. Because the parasitic capacitance is not well-controlled or stable, it is recommended that:  $f_{\text{SENSOR}} < 0.8 \times f_{\text{SR}}$ .



**Figure 59. Example Coil Inductance vs. Frequency**

In [Figure 59](#), the inductor has a SRF at 6.38 MHz; therefore the inductor should not be operated above  $0.8 \times 6.38$  MHz, or 5.1 MHz.

## 9 Power Supply Recommendations

- The LDC requires a voltage supply within 2.7 V and 3.6 V. A multilayer ceramic X7R bypass capacitor of 1  $\mu\text{F}$  between the VDD and GND pins is recommended. If the supply is located more than a few inches from the LDC, additional capacitance may be required in addition to the ceramic bypass capacitor. A ceramic capacitor with a value of 10  $\mu\text{F}$  is a typical choice.
- The optimum placement of bypass capacitors is closest to the VDD and GND terminals of the device. Care should be taken to minimize the loop area formed by the bypass capacitor connection, the VDD pin, and the GND pin of the IC. See [Figure 60](#) for a layout example.



## 11 Device and Documentation Support

### 11.1 Device Support

#### 11.1.1 Development Support

For related links, see the following:

- Texas Instruments' WEBENCH tool: <http://www.ti.com/webench>

### 11.2 Documentation Support

#### 11.2.1 Related Documentation

For related documentation, refer to the following:

- [LDC1000 Temperature Compensation](#) SNAA212
- [LDC Sensor Design](#) SNOA930
- [LDC1612/LDC1614 Linear Position Sensing Application Note](#) SNOA931
- [Optimizing L Measurement Resolution for the LDC1312 and LDC1314](#) SNOA945
- [Power Reduction Techniques for the LDC131x/161x for Inductive Sensing](#) SNOA949
- [Optimizing L Measurement Resolution for the LDC161x and LDC1101](#) SNOA950
- [Inductive Sensing Touch-On-Metal Buttons Design Guide](#) SNOA951
- [LDC Target Design](#) SNOA957
- [LDC1312, LDC1314, LDC1612, LDC1614 Sensor Status Monitoring](#) SNOA959
- [16 Button Inductive Touch Stainless Steel Keypad Reference Design](#)
- [Inductive Sensing 32-Position Encoder Knob Reference Design](#)
- [16-Button Inductive Keypad Reference Design](#)
- [1-Degree Dial Reference Design](#)

### 11.3 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

**Table 46. Related Links**

| PARTS   | PRODUCT FOLDER             | SAMPLE & BUY               | TECHNICAL DOCUMENTS        | TOOLS & SOFTWARE           | SUPPORT & COMMUNITY        |
|---------|----------------------------|----------------------------|----------------------------|----------------------------|----------------------------|
| LDC1312 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |
| LDC1314 | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> | <a href="#">Click here</a> |

### 11.4 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. In the upper right corner, click on Alert me to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

### 11.5 Community Resources

The following links connect to TI community resources. Linked contents are provided "AS IS" by the respective contributors. They do not constitute TI specifications and do not necessarily reflect TI's views; see TI's [Terms of Use](#).

**TI E2E™ Online Community** *TI's Engineer-to-Engineer (E2E) Community*. Created to foster collaboration among engineers. At e2e.ti.com, you can ask questions, share knowledge, explore ideas and help solve problems with fellow engineers.

**Design Support** *TI's Design Support* Quickly find helpful E2E forums along with design support tools and contact information for technical support.

## 11.6 Trademarks

E2E is a trademark of Texas Instruments.  
WEBENCH is a registered trademark of Texas Instruments.  
All other trademarks are the property of their respective owners.

## 11.7 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

## 11.8 Glossary

[SLYZ022](#) — *TI Glossary*.

This glossary lists and explains terms, acronyms, and definitions.

## 12 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

## PACKAGING INFORMATION

| Orderable Device | Status<br>(1) | Package Type | Package<br>Drawing | Pins | Package<br>Qty | Eco Plan<br>(2)            | Lead/Ball Finish<br>(6) | MSL Peak Temp<br>(3) | Op Temp (°C) | Device Marking<br>(4/5) | Samples                 |
|------------------|---------------|--------------|--------------------|------|----------------|----------------------------|-------------------------|----------------------|--------------|-------------------------|-------------------------|
| LDC1312DNTR      | ACTIVE        | WSO          | DNT                | 12   | 4500           | Green (RoHS<br>& no Sb/Br) | SN                      | Level-1-260C-UNLIM   | -40 to 125   | LDC1312                 | <a href="#">Samples</a> |
| LDC1312DNTR      | ACTIVE        | WSO          | DNT                | 12   | 250            | Green (RoHS<br>& no Sb/Br) | SN                      | Level-1-260C-UNLIM   | -40 to 125   | LDC1312                 | <a href="#">Samples</a> |
| LDC1314RGHR      | ACTIVE        | WQFN         | RGH                | 16   | 4500           | Green (RoHS<br>& no Sb/Br) | SN                      | Level-1-260C-UNLIM   | -40 to 125   | LDC1314                 | <a href="#">Samples</a> |
| LDC1314RGHT      | ACTIVE        | WQFN         | RGH                | 16   | 250            | Green (RoHS<br>& no Sb/Br) | SN                      | Level-1-260C-UNLIM   | -40 to 125   | LDC1314                 | <a href="#">Samples</a> |

(1) The marketing status values are defined as follows:

**ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

**NRND:** Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSELETE:** TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

**RoHS Exempt:** TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "-" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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continues to take reasonable steps to provide representative and accurate information but may not have conducted destructive testing or chemical analysis on incoming materials and chemicals. TI and TI suppliers consider certain information to be proprietary, and thus CAS numbers and other limited information may not be available for release.

In no event shall TI's liability arising out of such information exceed the total purchase price of the TI part(s) at issue in this document sold by TI to Customer on an annual basis.

**OTHER QUALIFIED VERSIONS OF LDC1312, LDC1314 :**

- Automotive: [LDC1312-Q1](#), [LDC1314-Q1](#)

**NOTE: Qualified Version Definitions:**

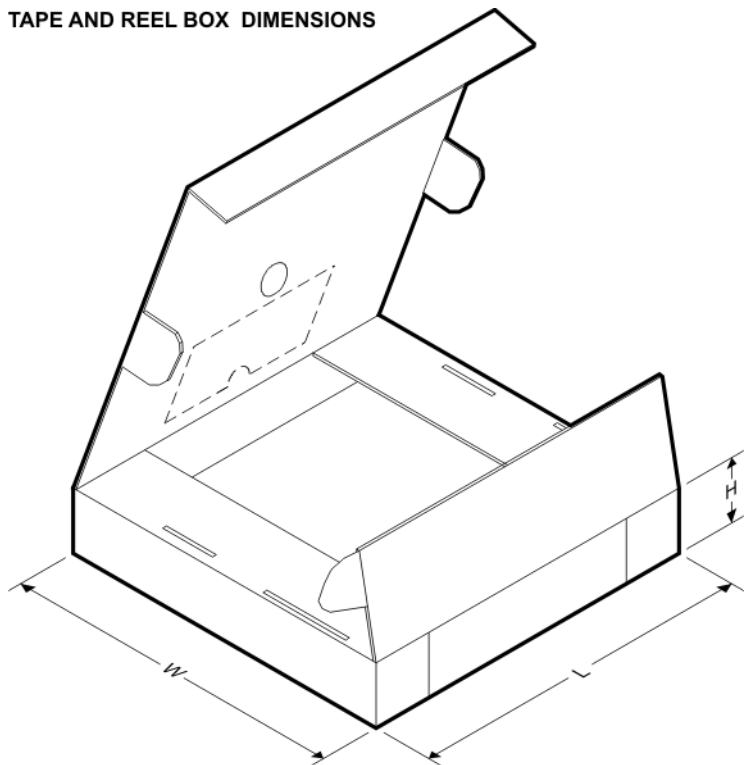
- Automotive - Q100 devices qualified for high-reliability automotive applications targeting zero defects

**TAPE AND REEL INFORMATION**


\*All dimensions are nominal

| Device      | Package Type | Package Drawing | Pins | SPQ  | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
|-------------|--------------|-----------------|------|------|--------------------|--------------------|---------|---------|---------|---------|--------|---------------|
| LDC1312DNTR | WSO          | DNT             | 12   | 4500 | 330.0              | 12.4               | 4.3     | 4.3     | 1.3     | 8.0     | 12.0   | Q1            |
| LDC1312DNTR | WSO          | DNT             | 12   | 250  | 178.0              | 12.4               | 4.3     | 4.3     | 1.3     | 8.0     | 12.0   | Q1            |
| LDC1314RGHR | WQFN         | RGH             | 16   | 4500 | 330.0              | 12.4               | 4.3     | 4.3     | 1.3     | 8.0     | 12.0   | Q1            |
| LDC1314RGHT | WQFN         | RGH             | 16   | 250  | 178.0              | 12.4               | 4.3     | 4.3     | 1.3     | 8.0     | 12.0   | Q1            |

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

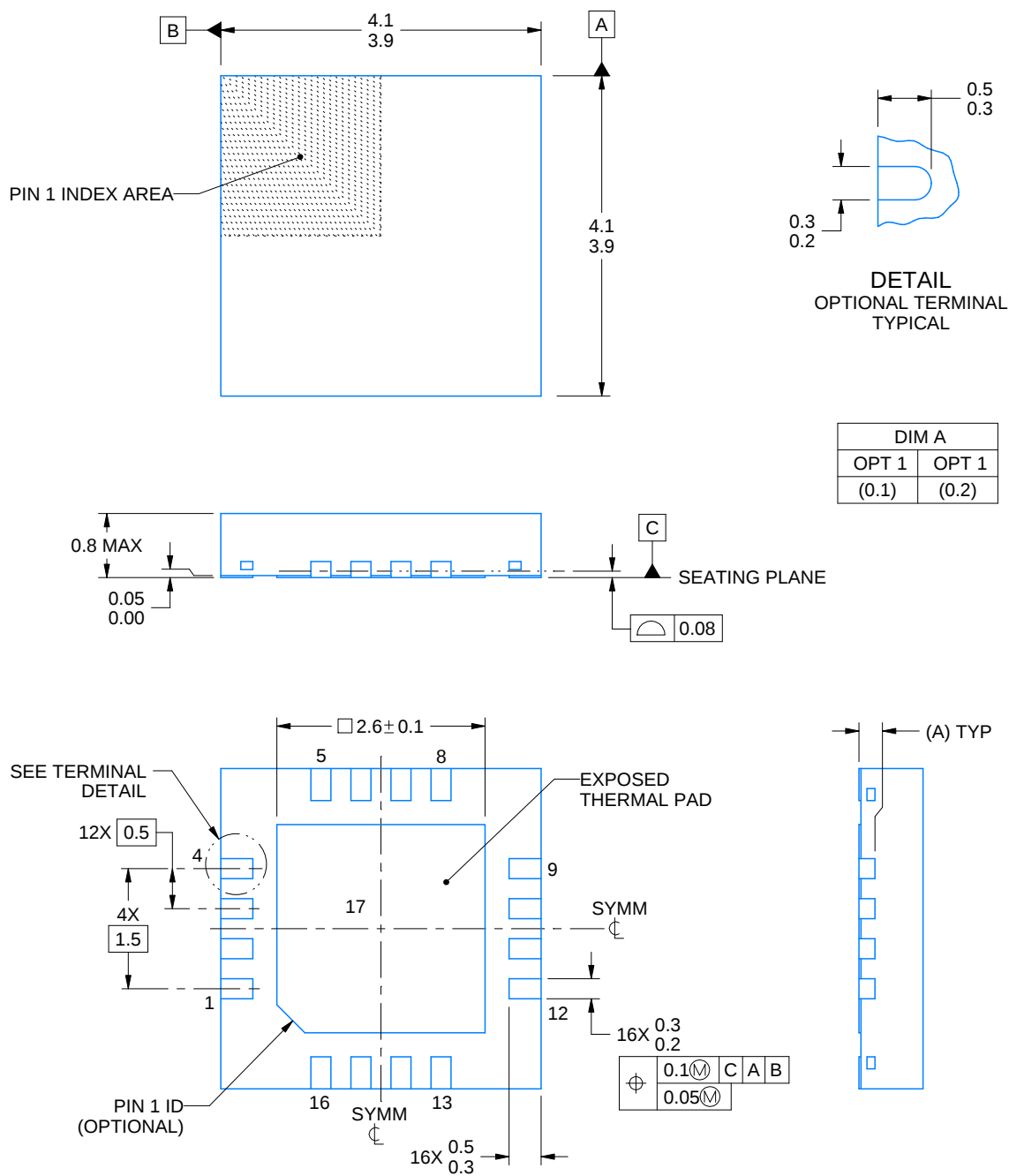
| Device      | Package Type | Package Drawing | Pins | SPQ  | Length (mm) | Width (mm) | Height (mm) |
|-------------|--------------|-----------------|------|------|-------------|------------|-------------|
| LDC1312DNTR | WSON         | DNT             | 12   | 4500 | 367.0       | 367.0      | 35.0        |
| LDC1312DNTR | WSON         | DNT             | 12   | 250  | 210.0       | 185.0      | 35.0        |
| LDC1314RGHR | WQFN         | RGH             | 16   | 4500 | 367.0       | 367.0      | 35.0        |
| LDC1314RGHT | WQFN         | RGH             | 16   | 250  | 210.0       | 185.0      | 35.0        |



## PACKAGE OUTLINE

**WQFN - 0.8 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



4214978/B 01/2017

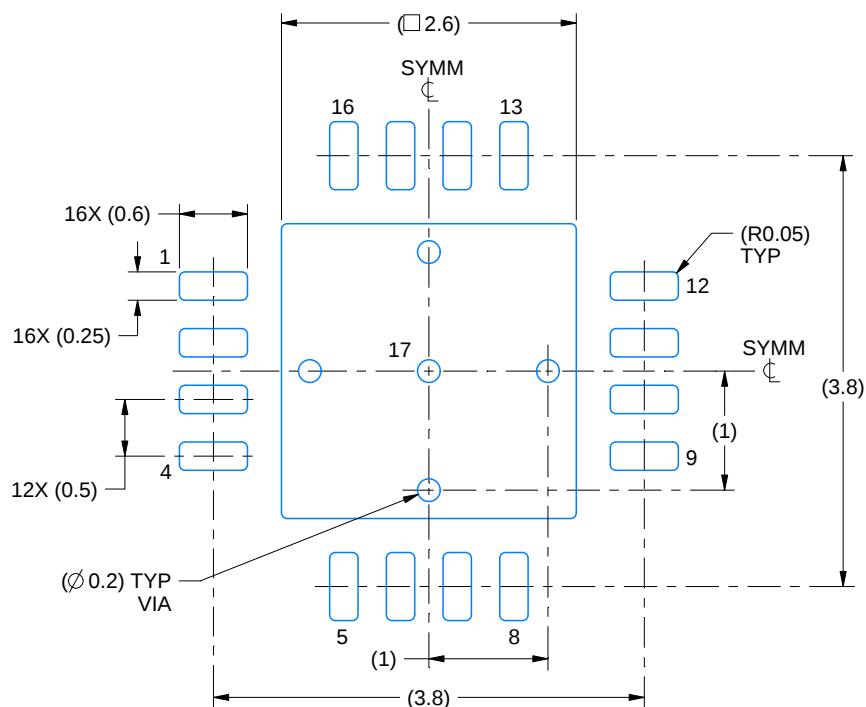
NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. The package thermal pad must be soldered to the printed circuit board for optimal thermal and mechanical performance.

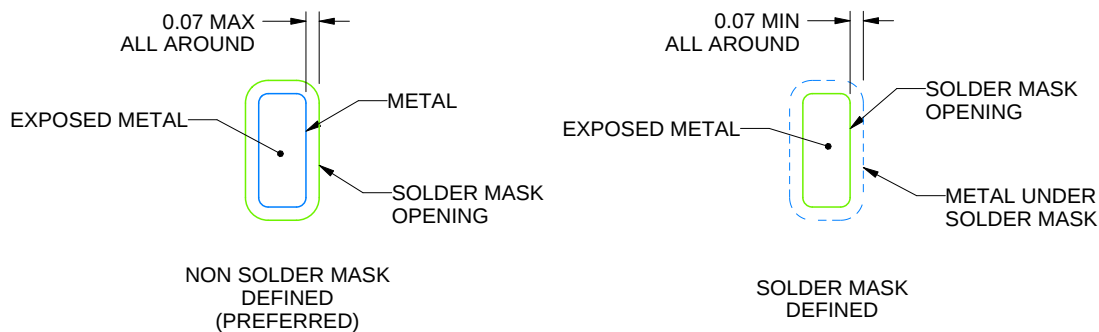
**RGH0016A**

**WQFN - 0.8 mm max height**

PLASTIC QUAD FLATPACK - NO LEAD



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:15X



## SOLDER MASK DETAILS

4214978/B 01/2017

NOTES: (continued)

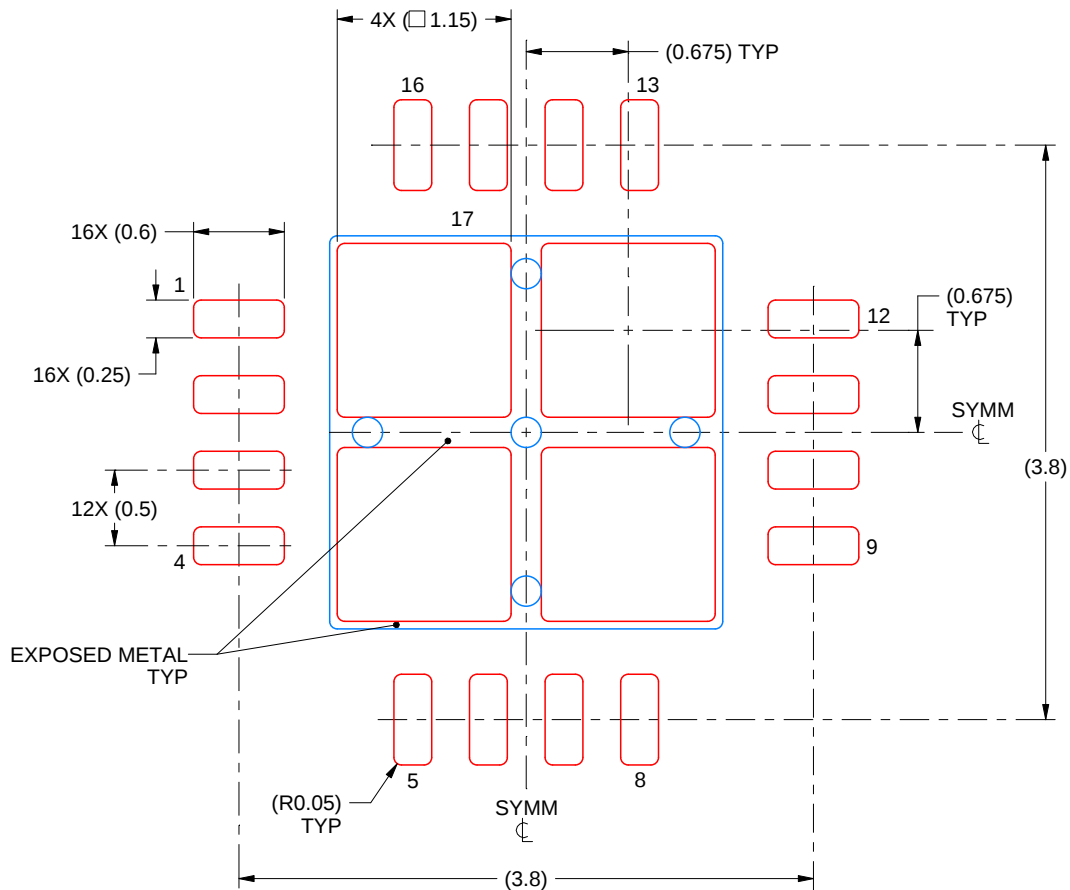
4. This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).
5. Vias are optional depending on application, refer to device data sheet. If any vias are implemented, refer to their locations shown on this view. It is recommended that vias under paste be filled, plugged or tented.

# EXAMPLE STENCIL DESIGN

RGH0016A

WQFN - 0.8 mm max height

PLASTIC QUAD FLATPACK - NO LEAD



**SOLDER PASTE EXAMPLE**  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD 17  
78% PRINTED SOLDER COVERAGE BY AREA UNDER PACKAGE  
SCALE:20X

4214978/B 01/2017

NOTES: (continued)

6. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

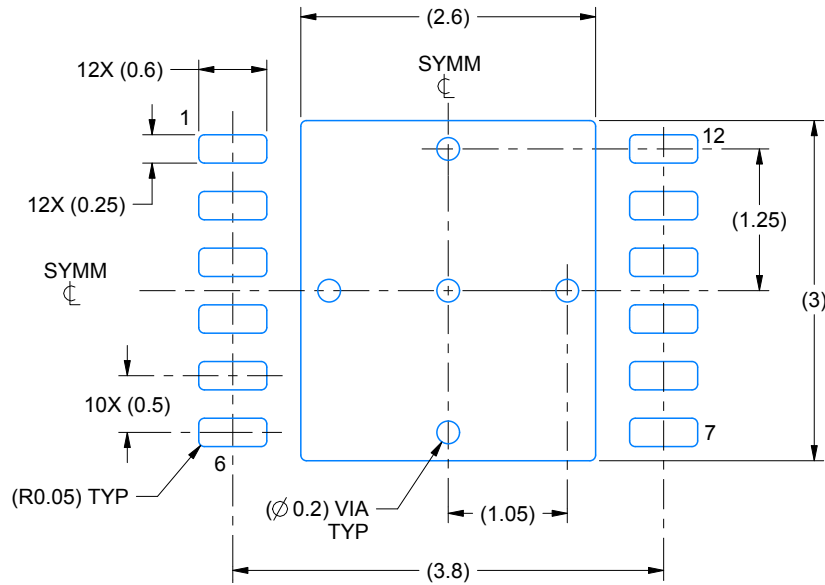


# EXAMPLE BOARD LAYOUT

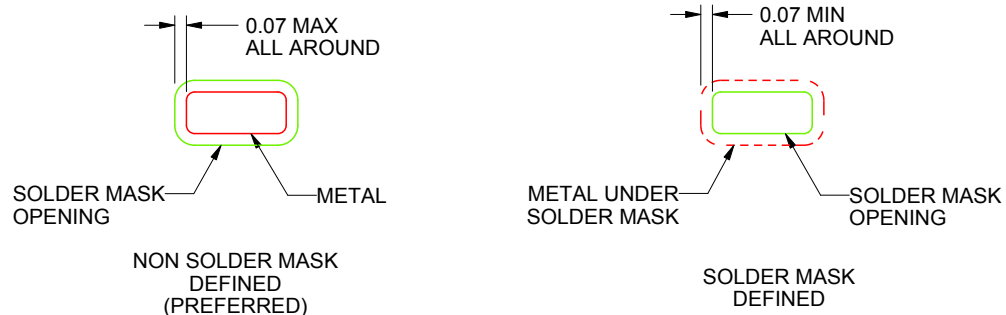
DNT0012B

WSN - 0.8 mm max height

PLASTIC SMALL OUTLINE - NO LEAD



LAND PATTERN EXAMPLE  
SCALE:15X



SOLDER MASK DETAILS

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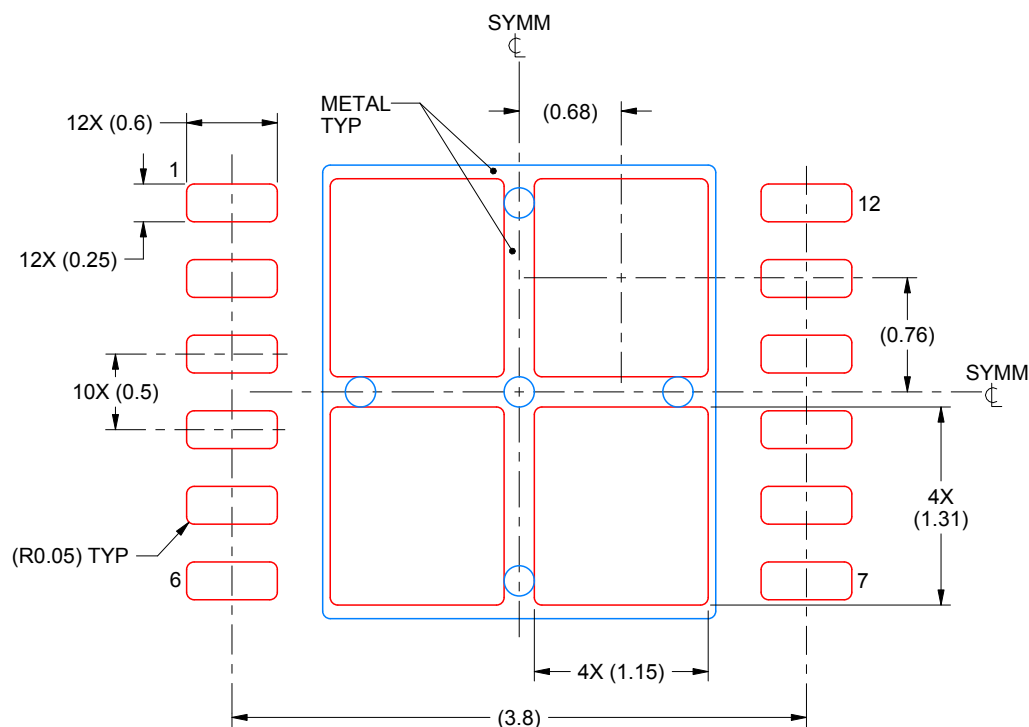
NOTES: (continued)

- This package is designed to be soldered to a thermal pad on the board. For more information, see Texas Instruments literature number SLUA271 ([www.ti.com/lit/sluea271](http://www.ti.com/lit/sluea271)).

**DNT0012B**

**WSON - 0.8 mm max height**

PLASTIC SMALL OUTLINE - NO LEAD



SOLDER PASTE EXAMPLE  
BASED ON 0.125 mm THICK STENCIL

EXPOSED PAD  
77% PRINTED SOLDER COVERAGE BY AREA  
SCALE:20X

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NOTES: (continued)

5. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.

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